

Title: ELECTROPOLISHING AND
ELECTROPLATING METHODS
Inventor: Hui WANG et al.
Application No.: Not Yet Assigned
Docket No.: 495152001000

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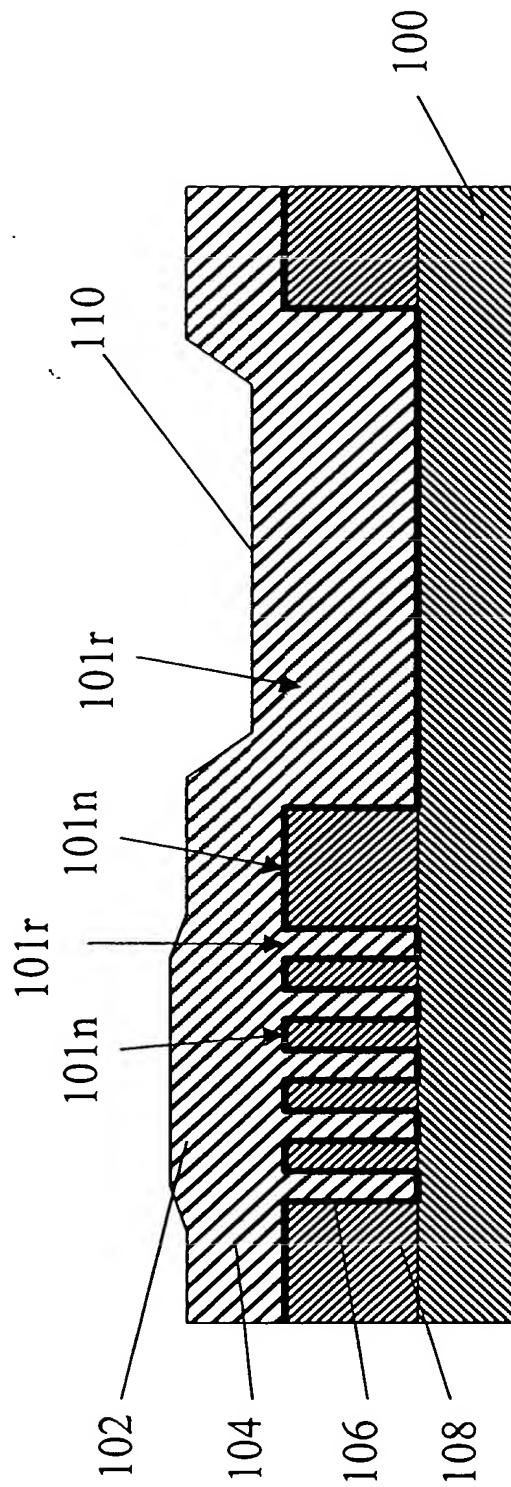


Fig. 1A

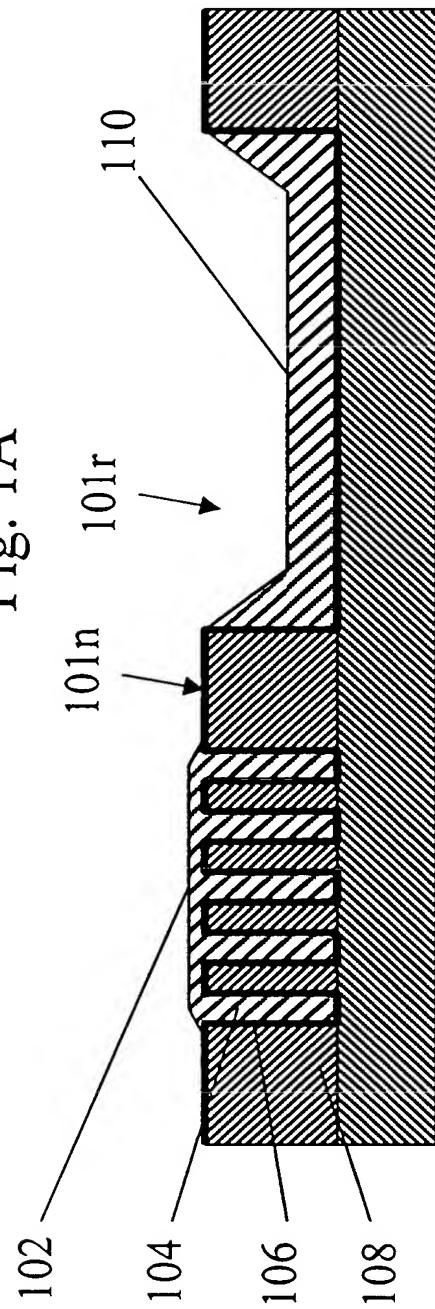


Fig. 1B

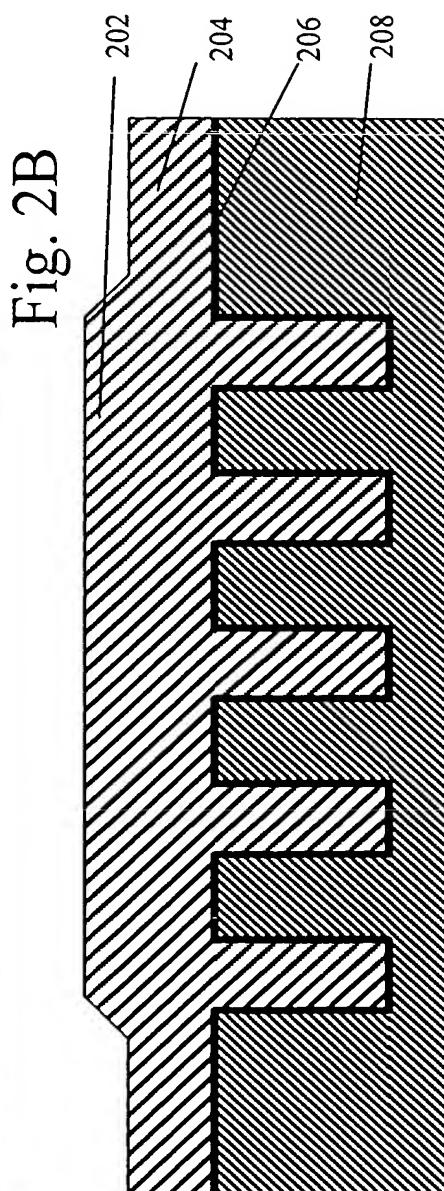
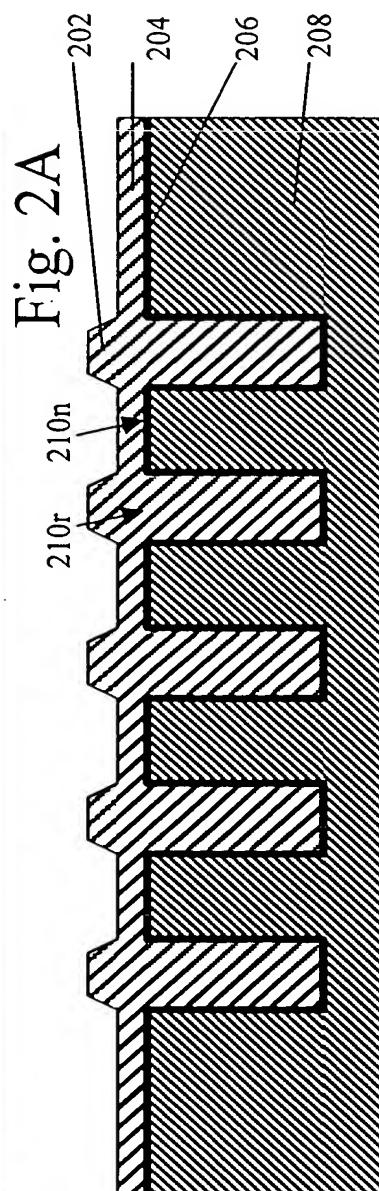
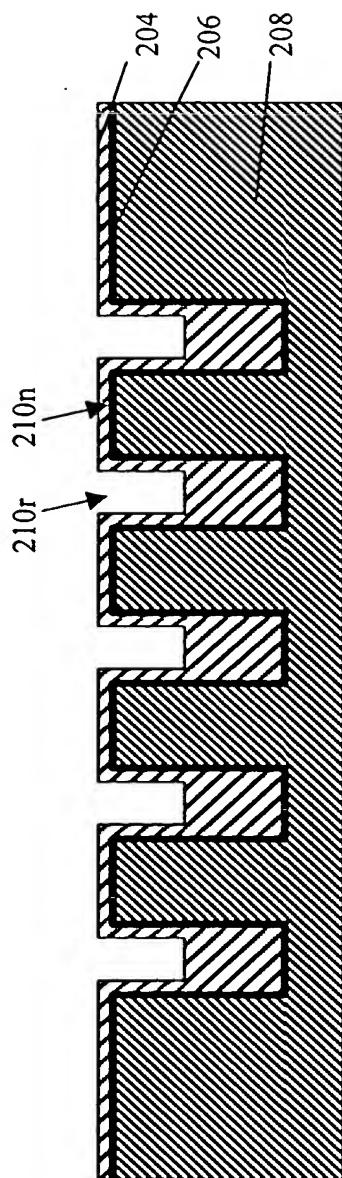


Fig. 2C

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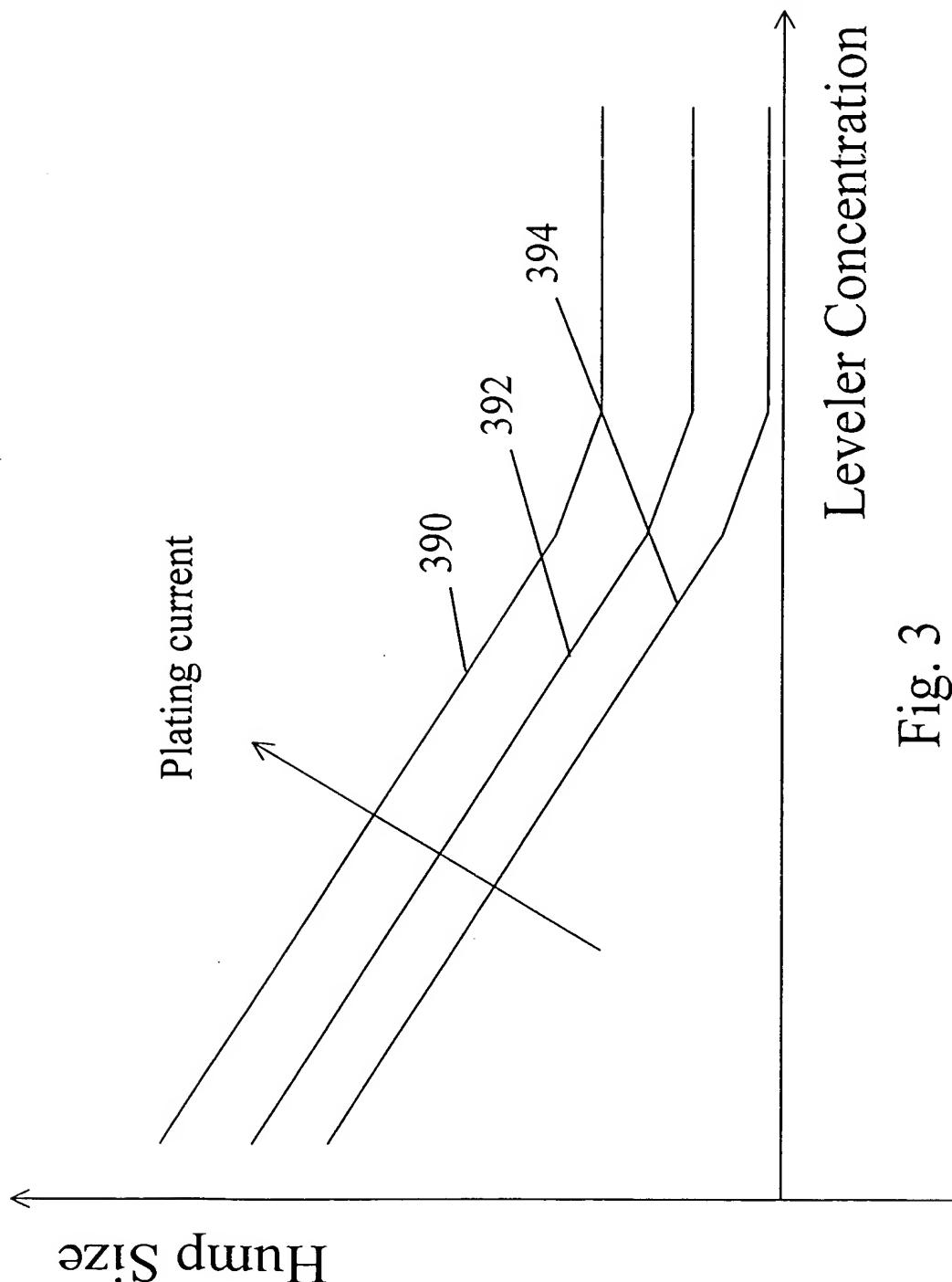


Fig. 3

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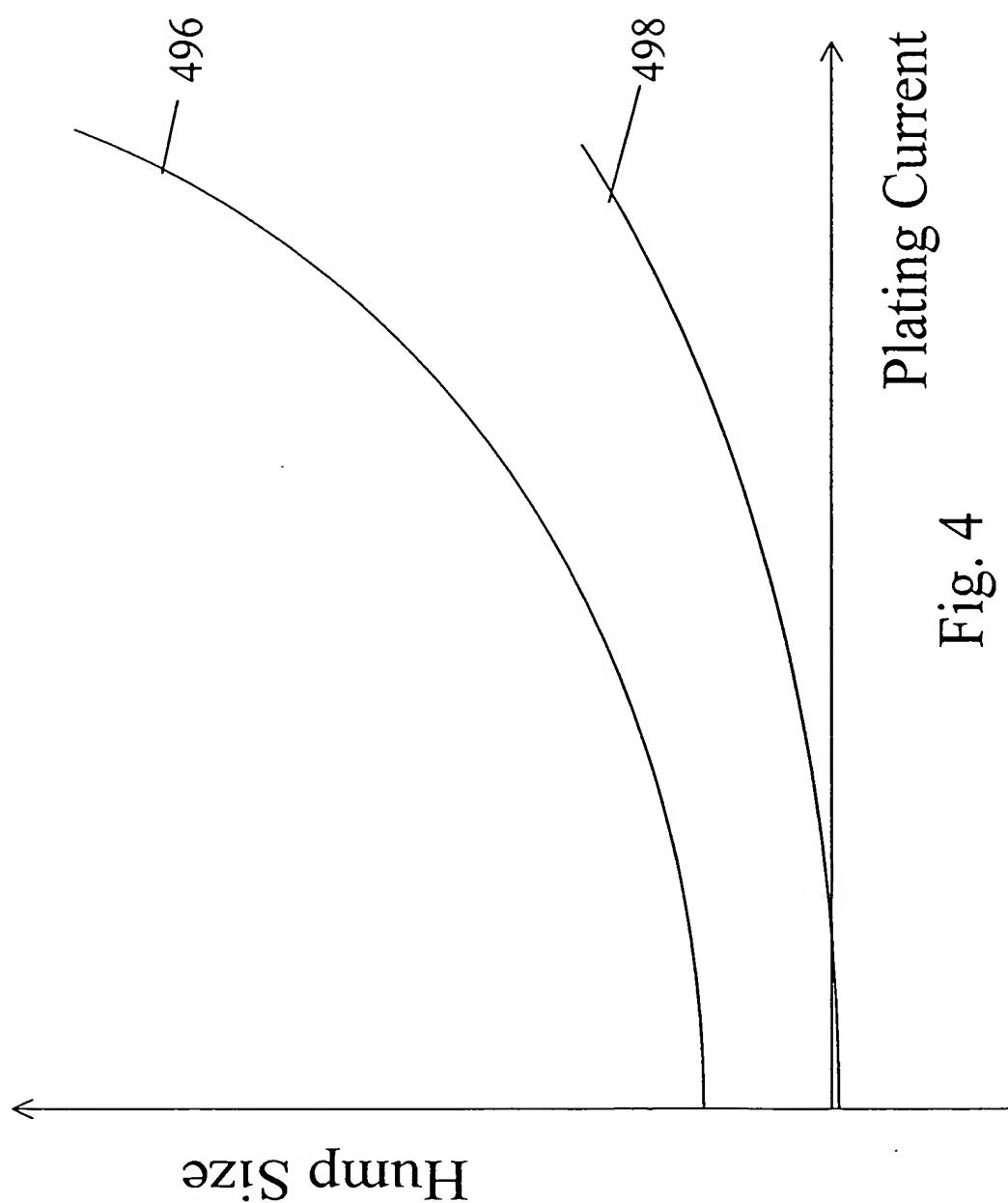
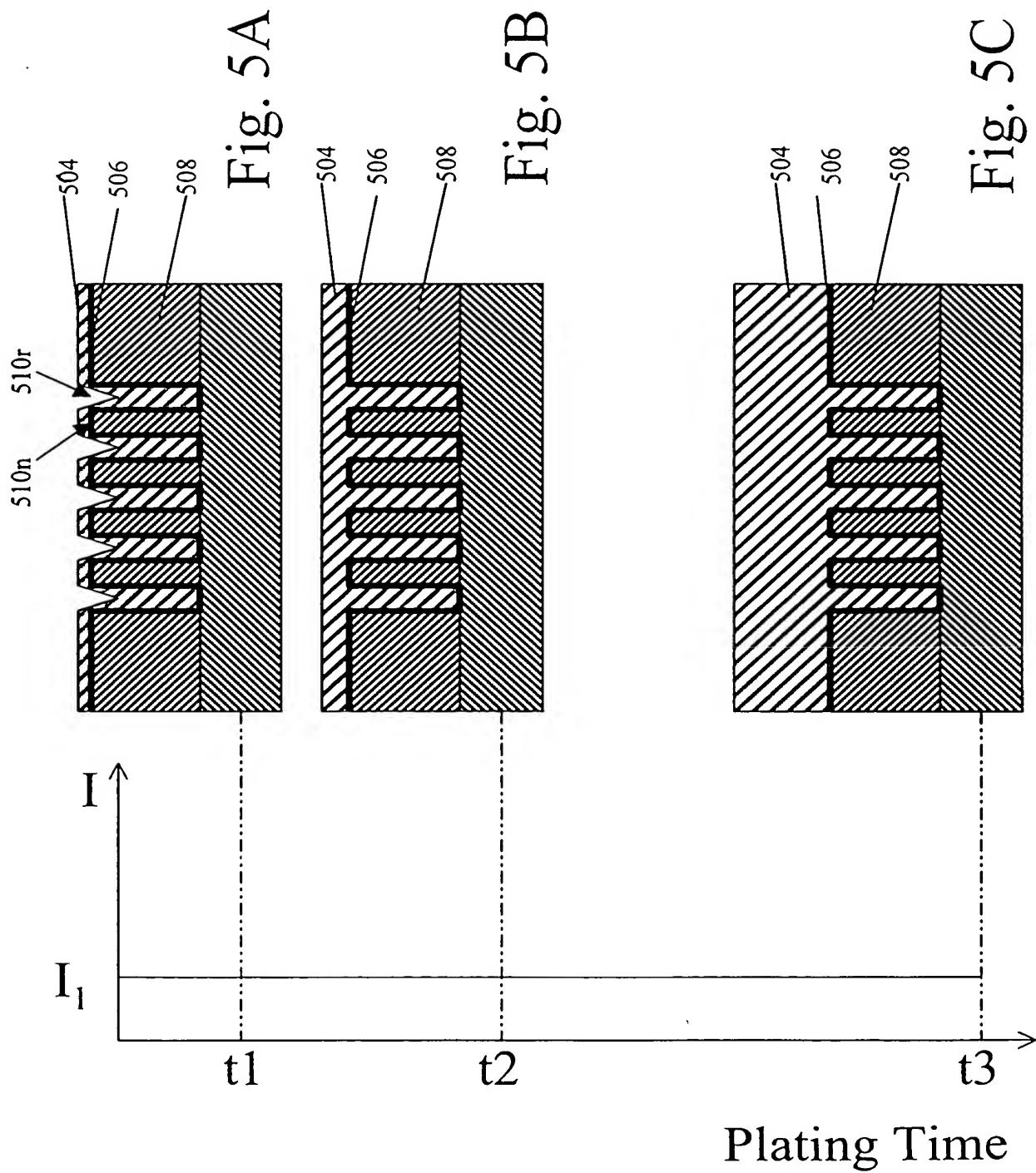
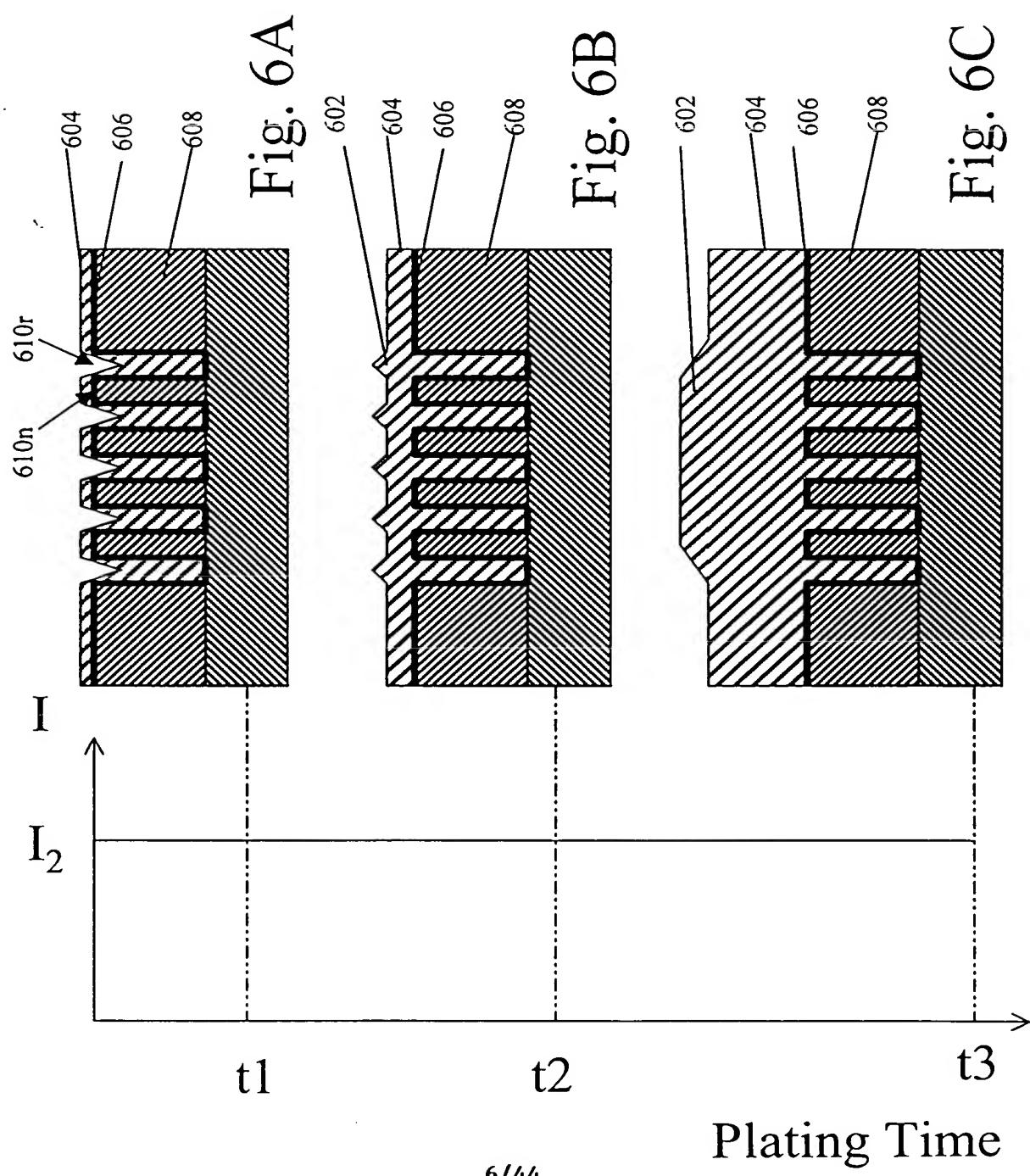
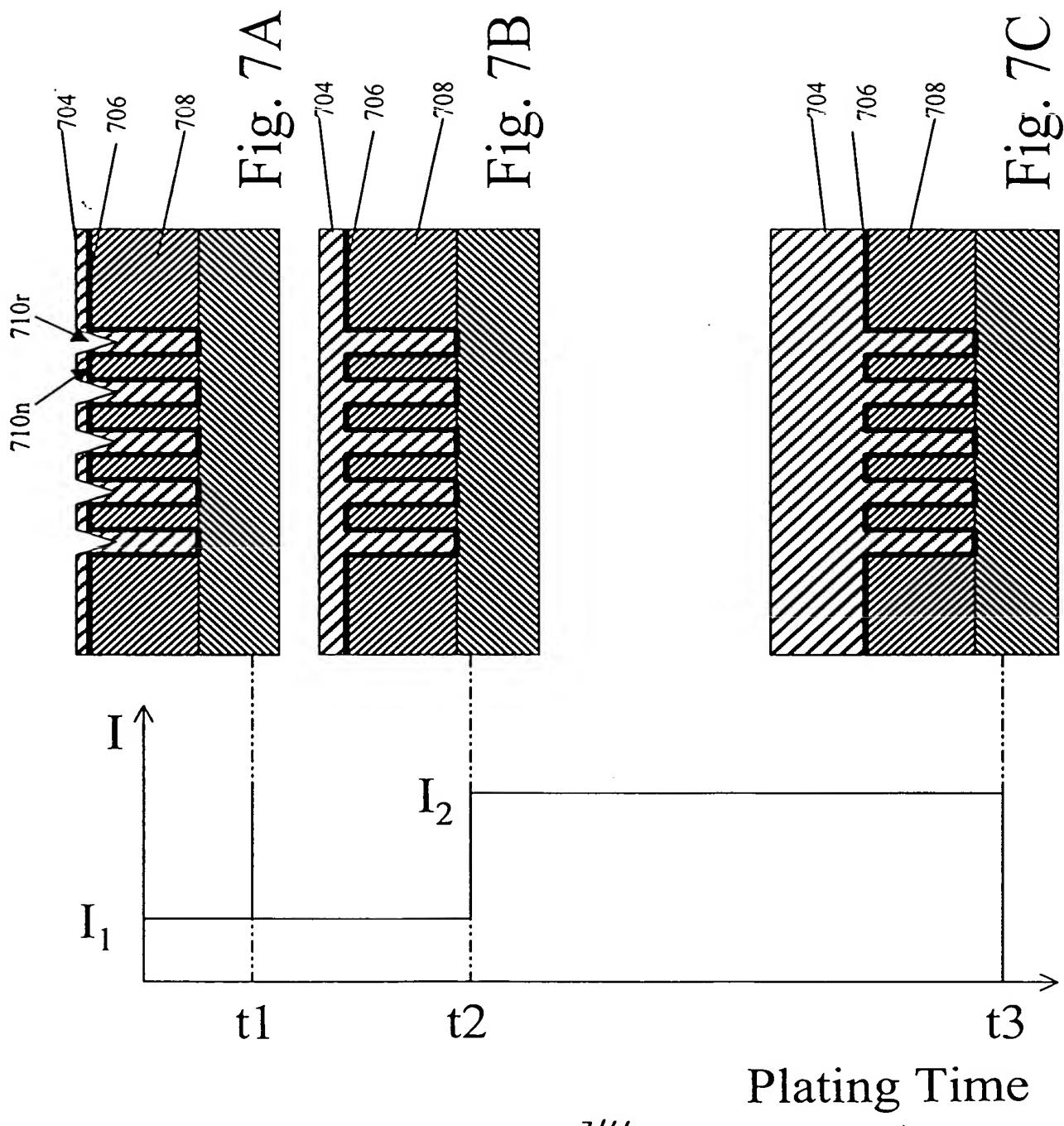


Fig. 4







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Fig. 8A

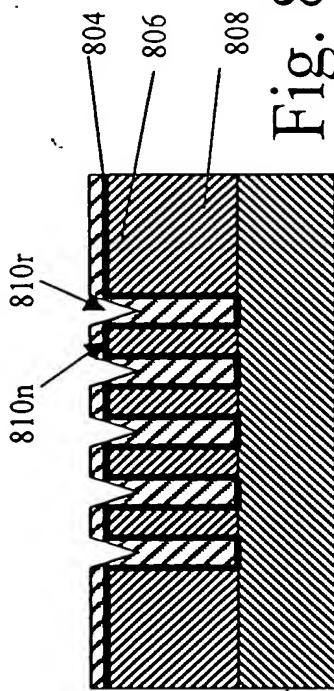
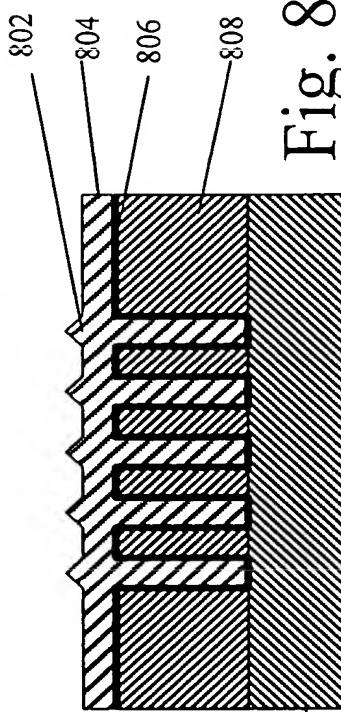
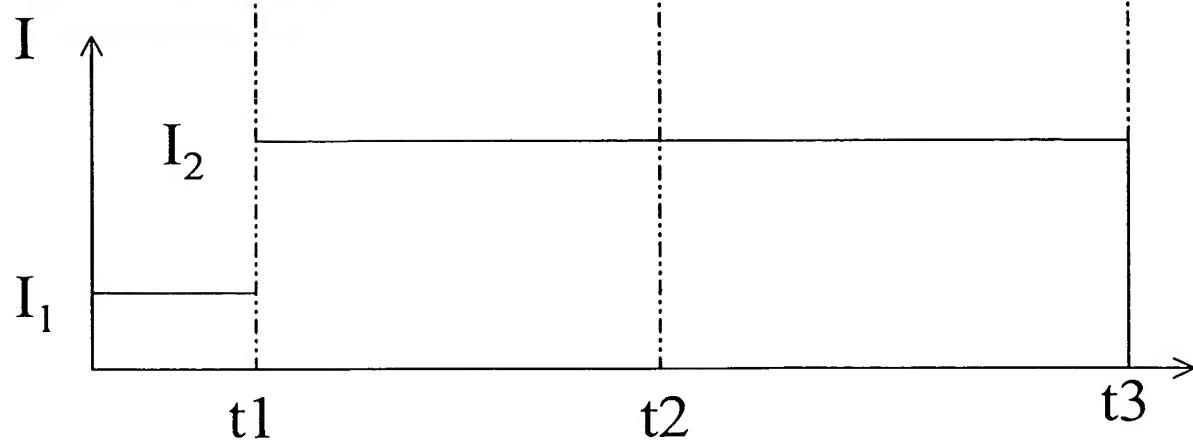
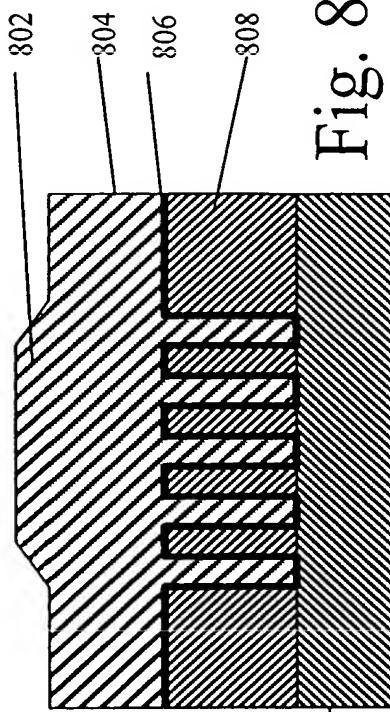


Fig. 8B



8C
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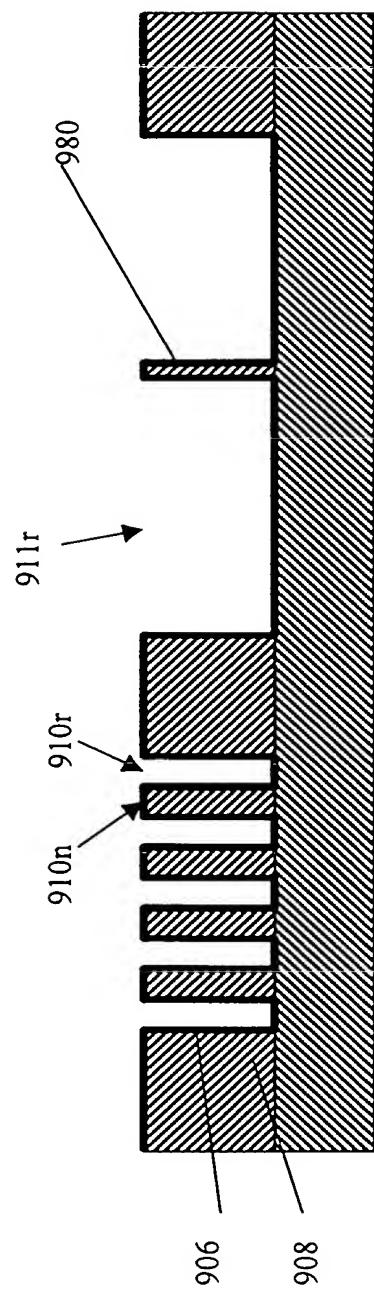
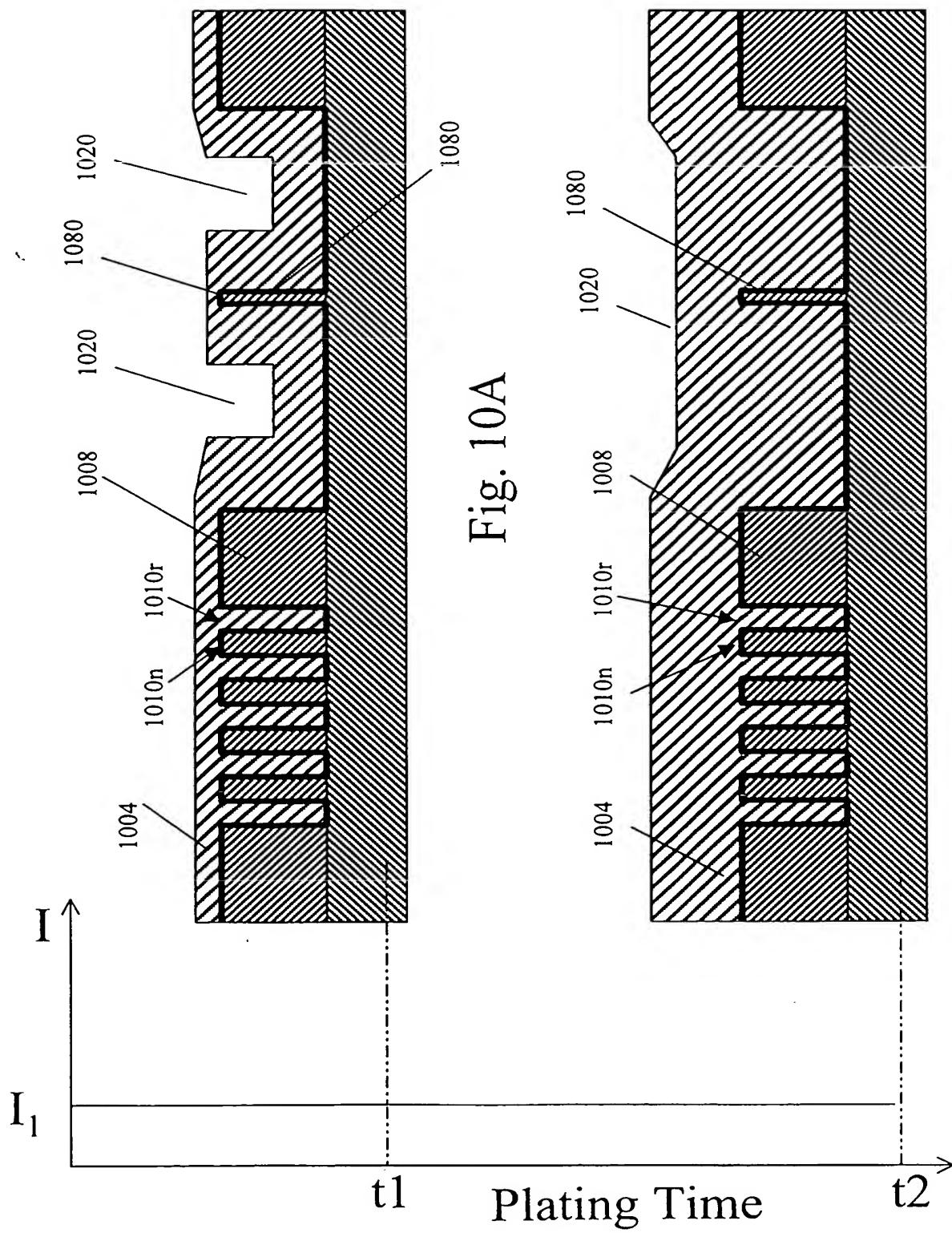


Fig. 9

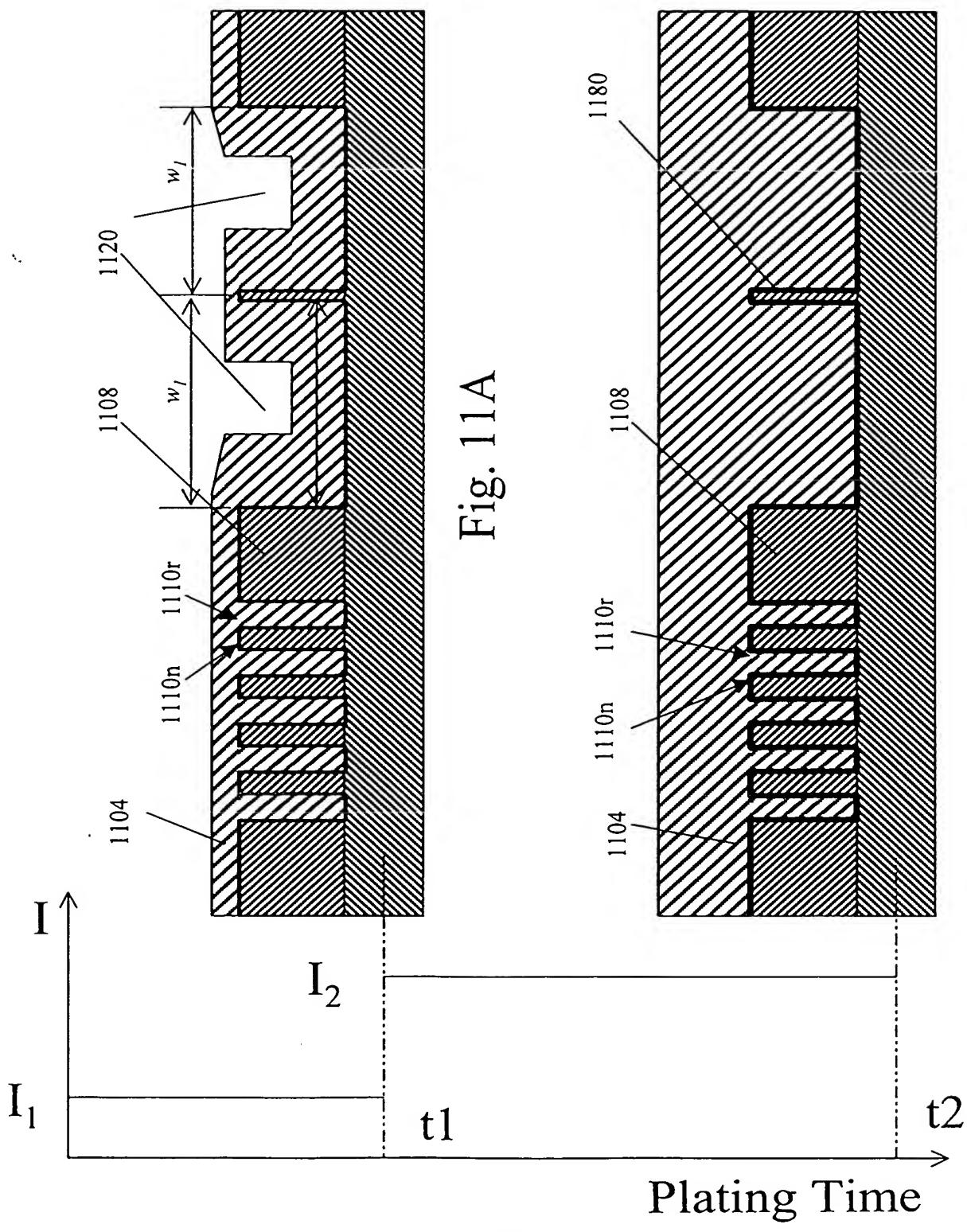
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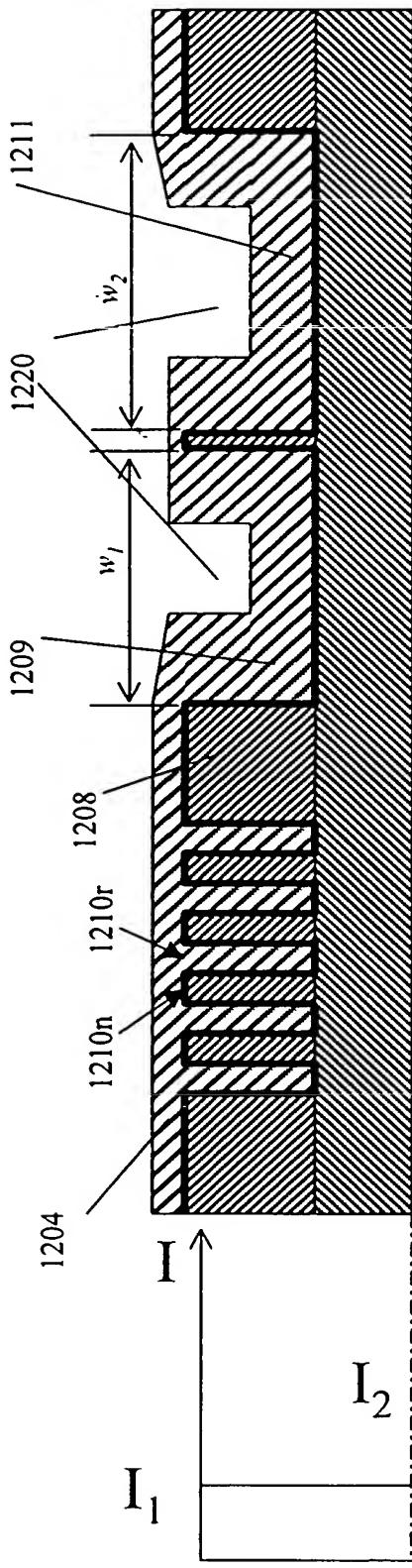


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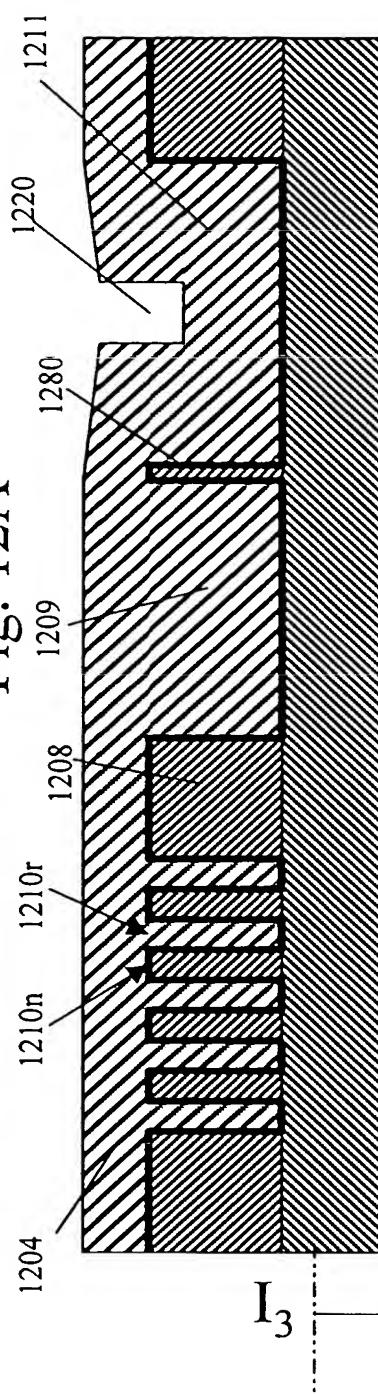


Fig. 12B

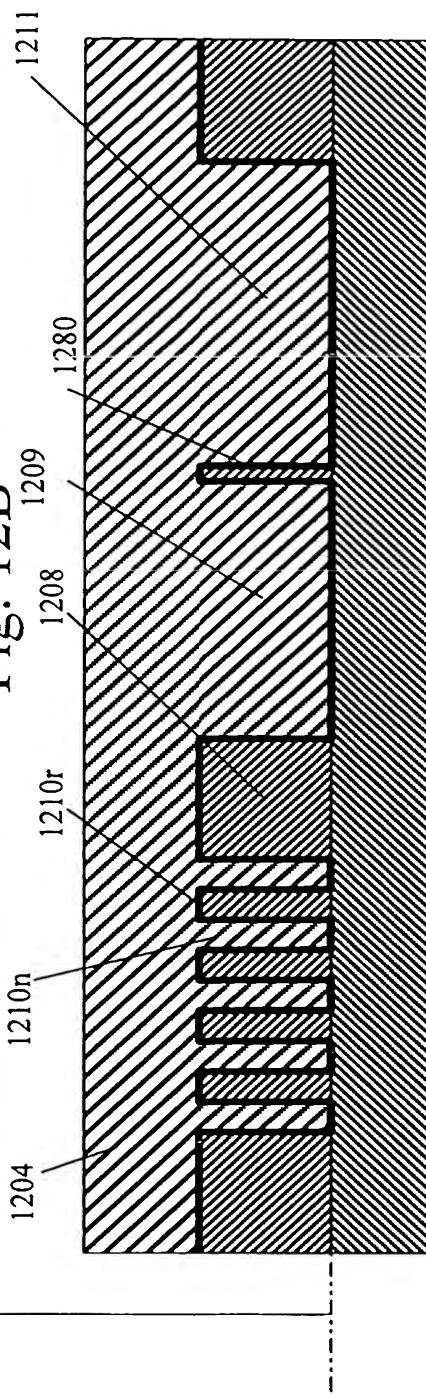


Fig. 12C

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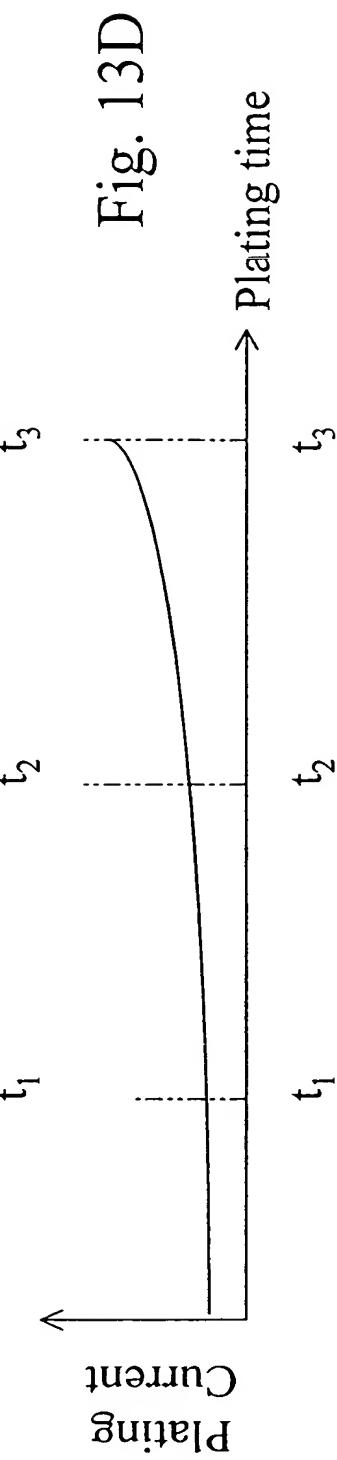
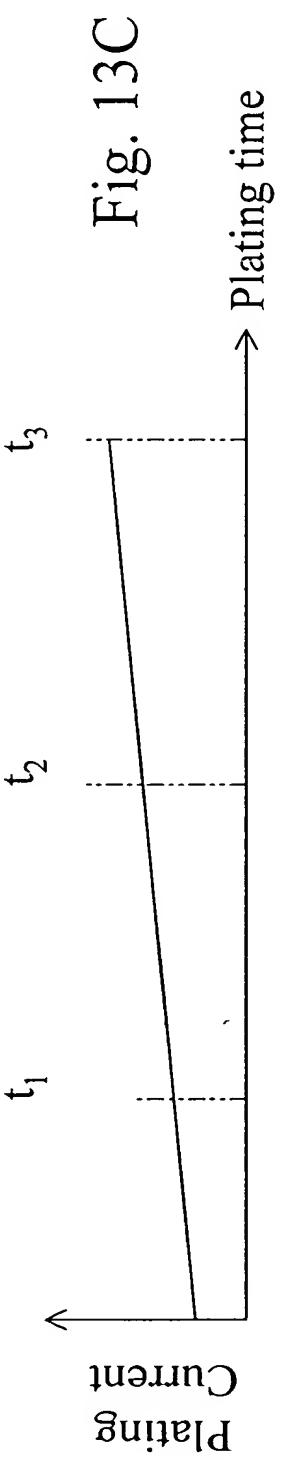
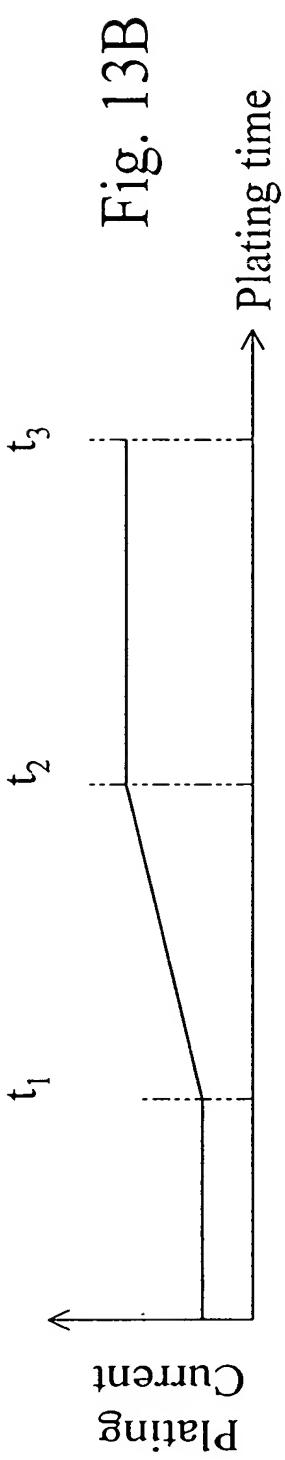
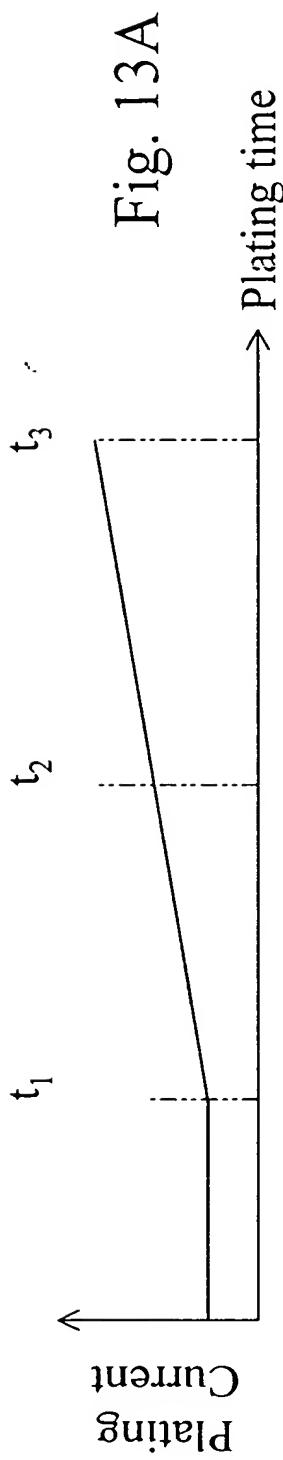


Fig. 13E

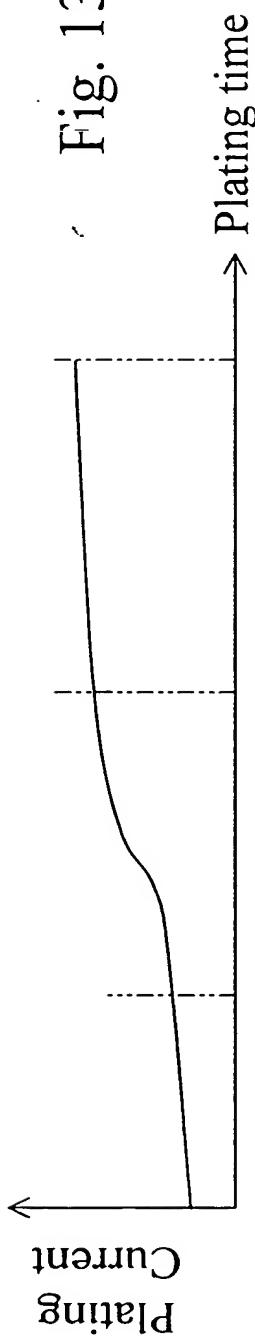


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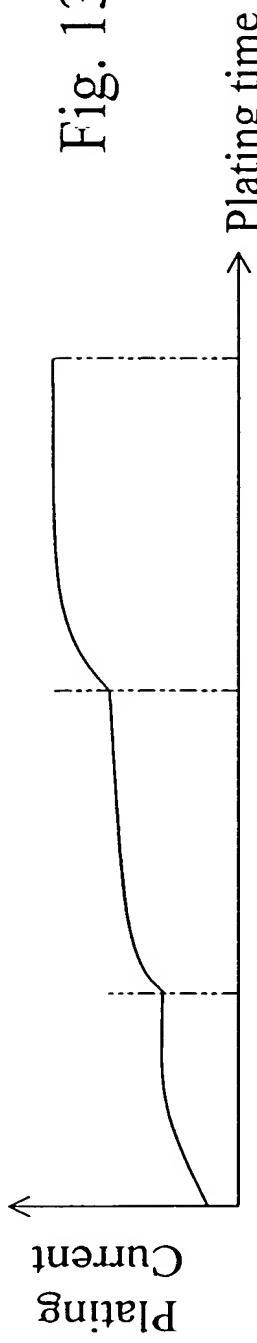


Fig. 13G

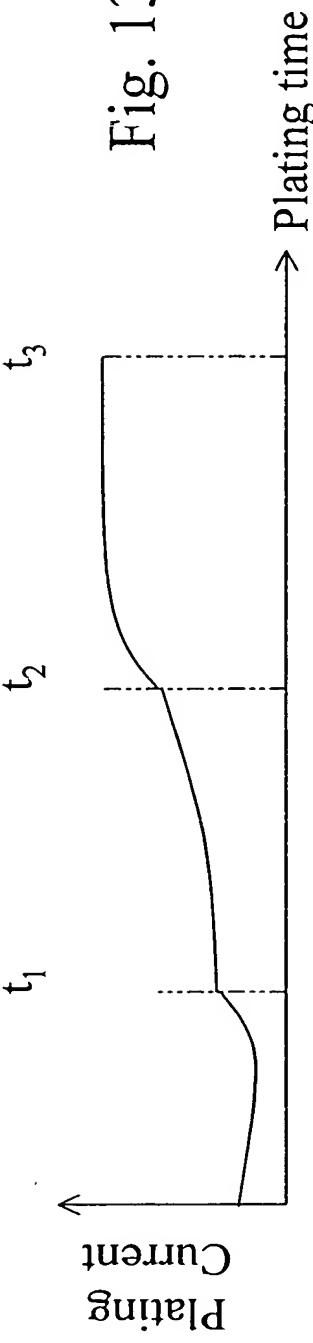
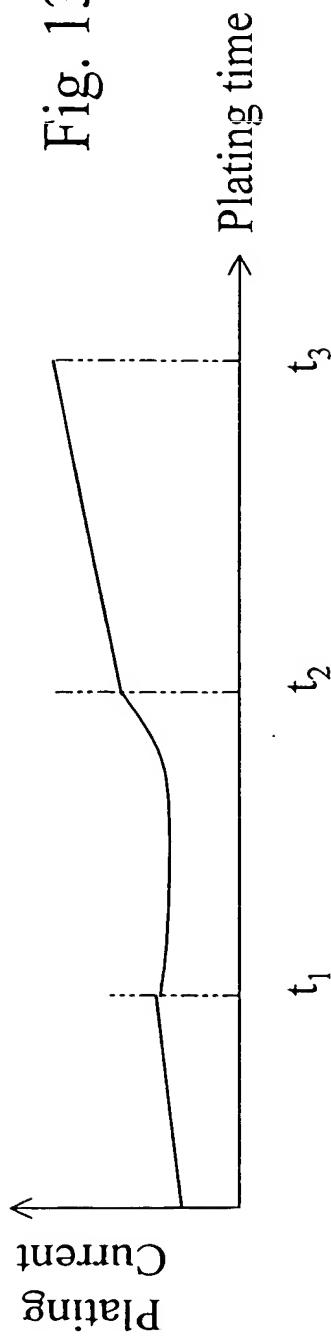


Fig. 13H



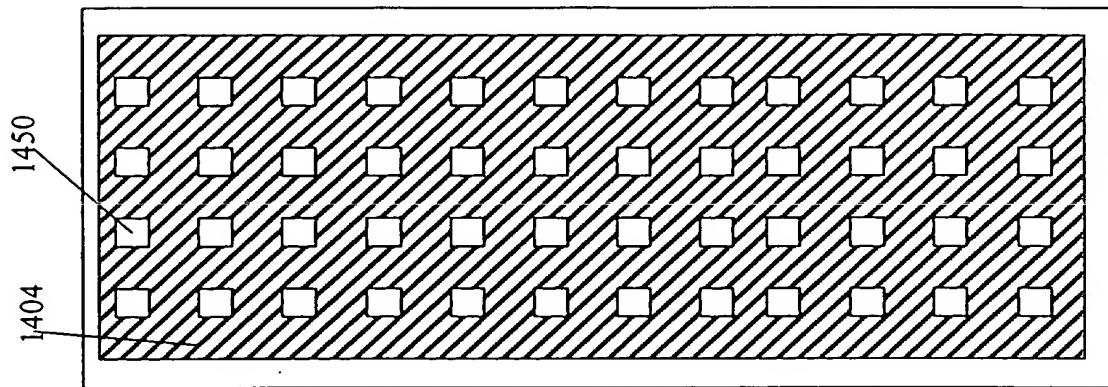


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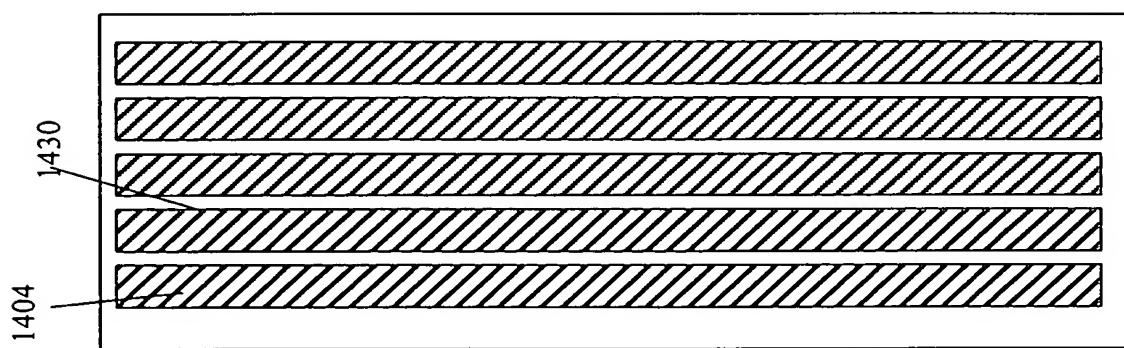


Fig. 14B

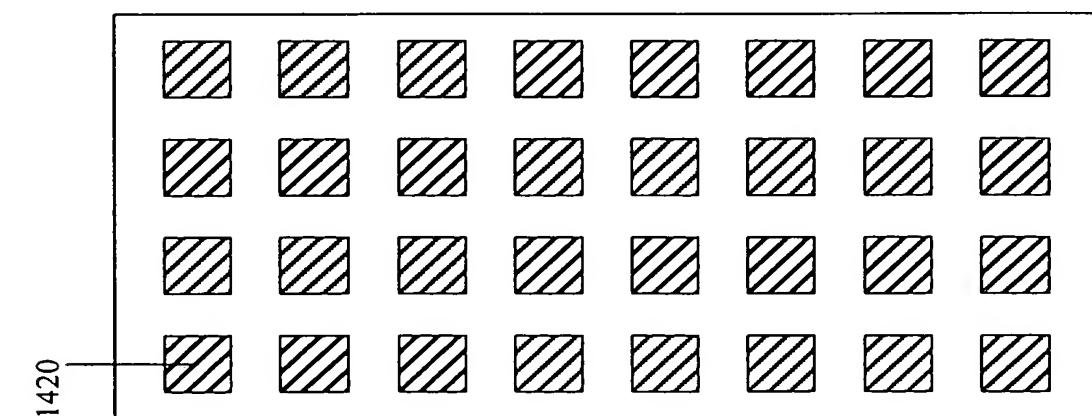


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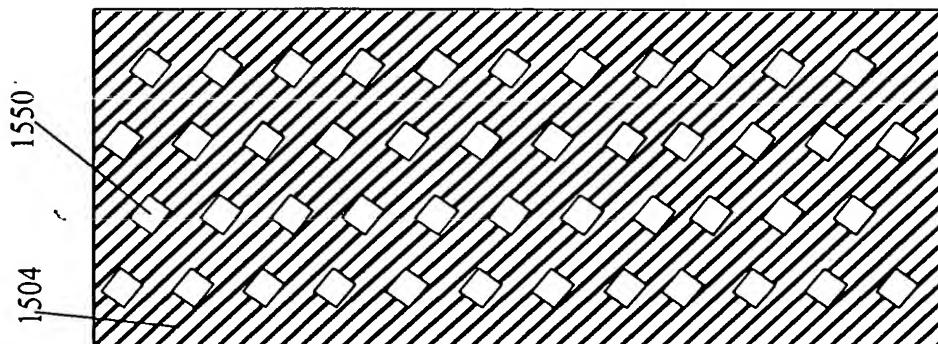


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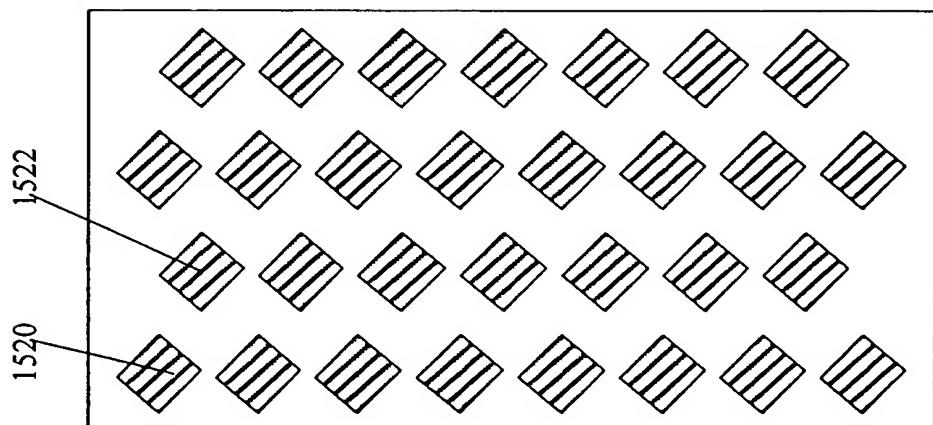


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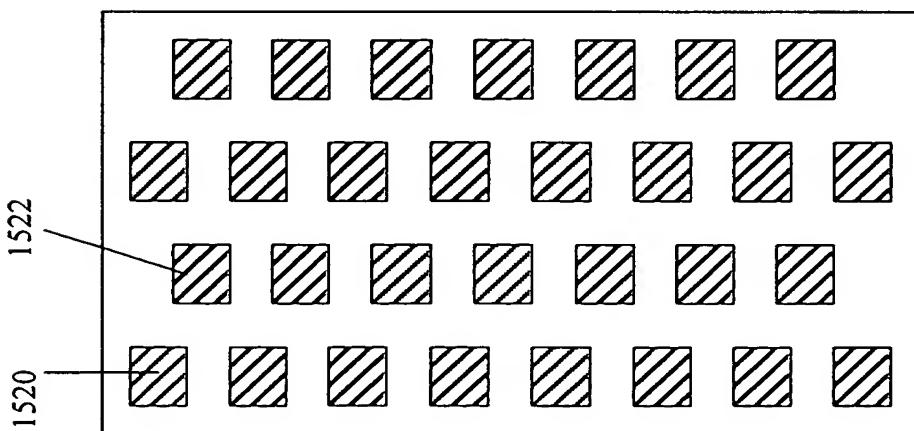


Fig. 15A

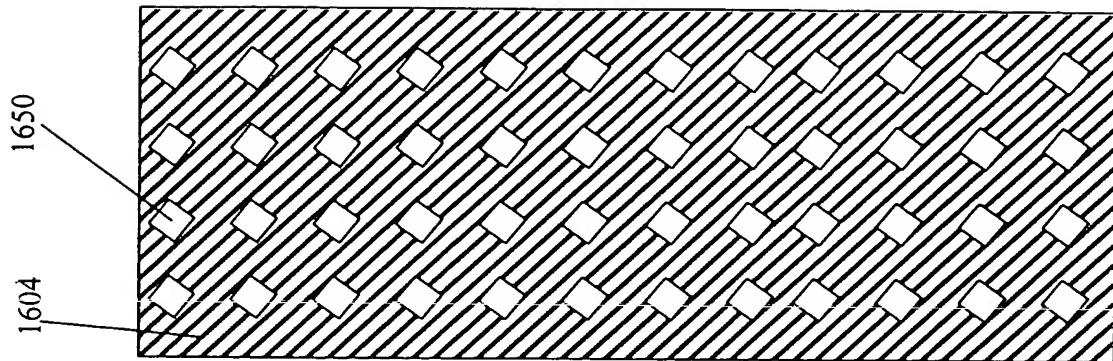


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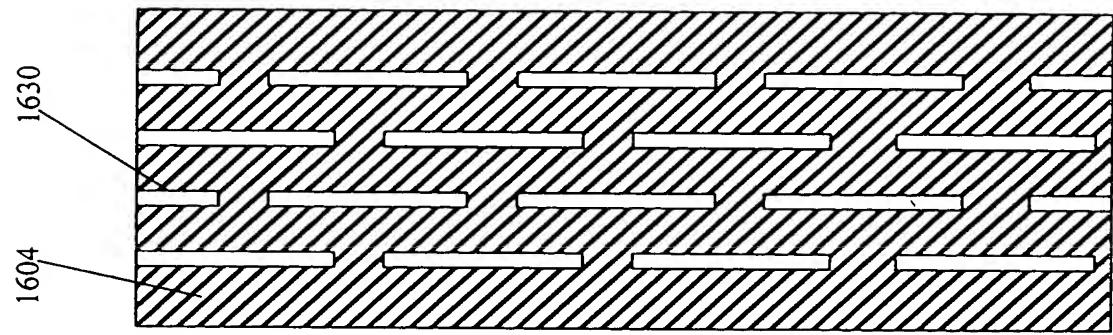


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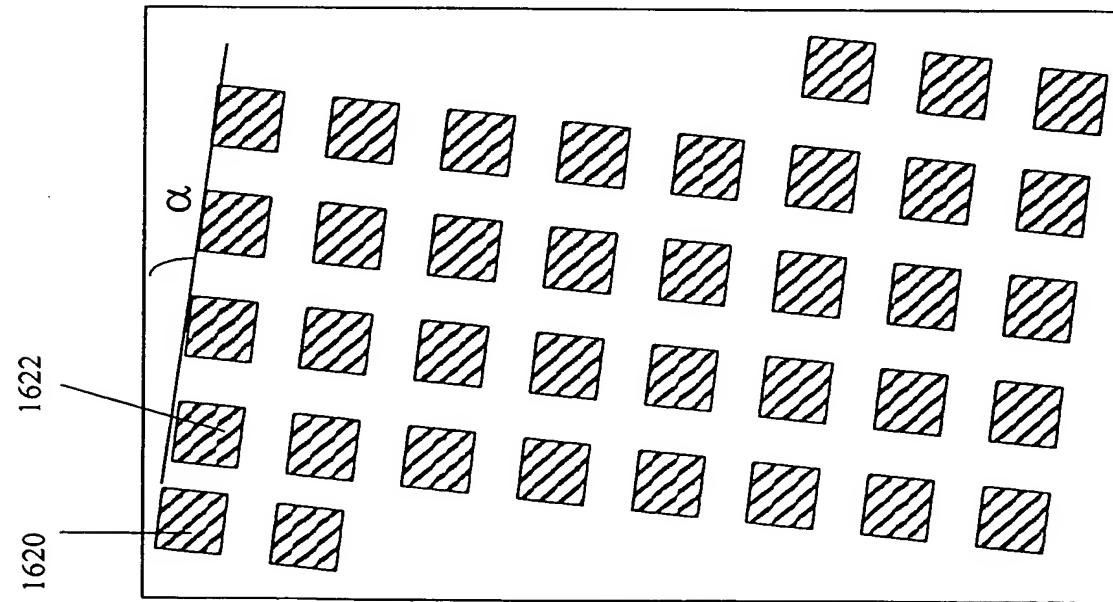


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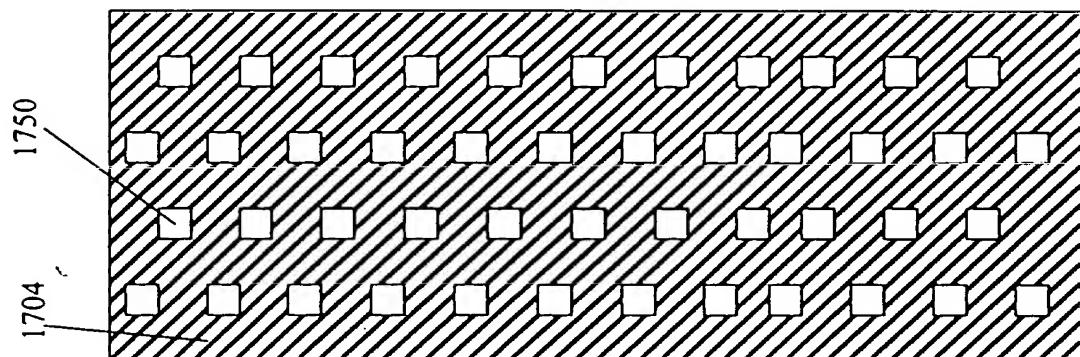


Fig. 17C

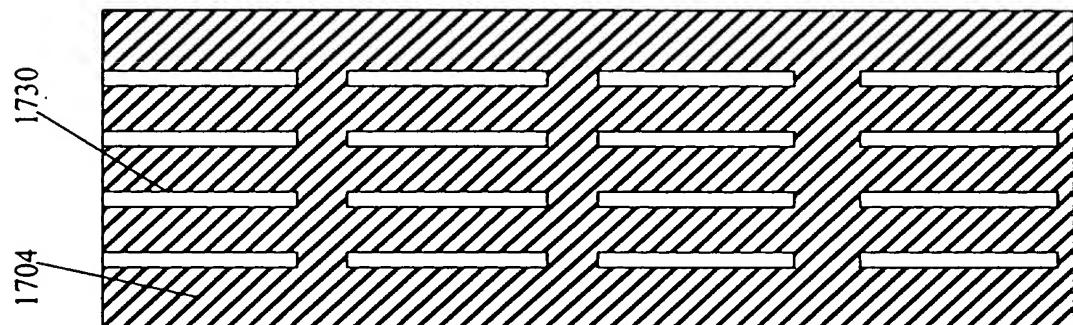


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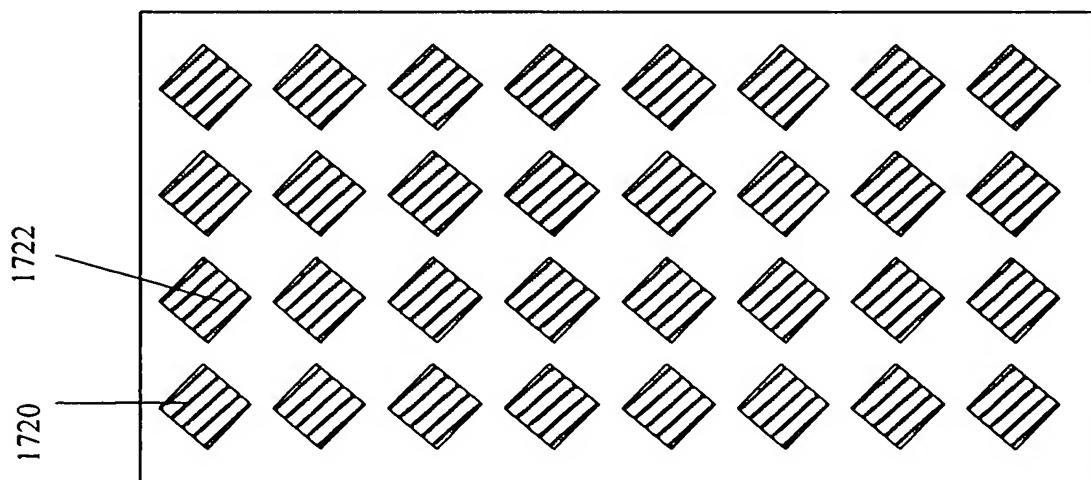


Fig. 17A

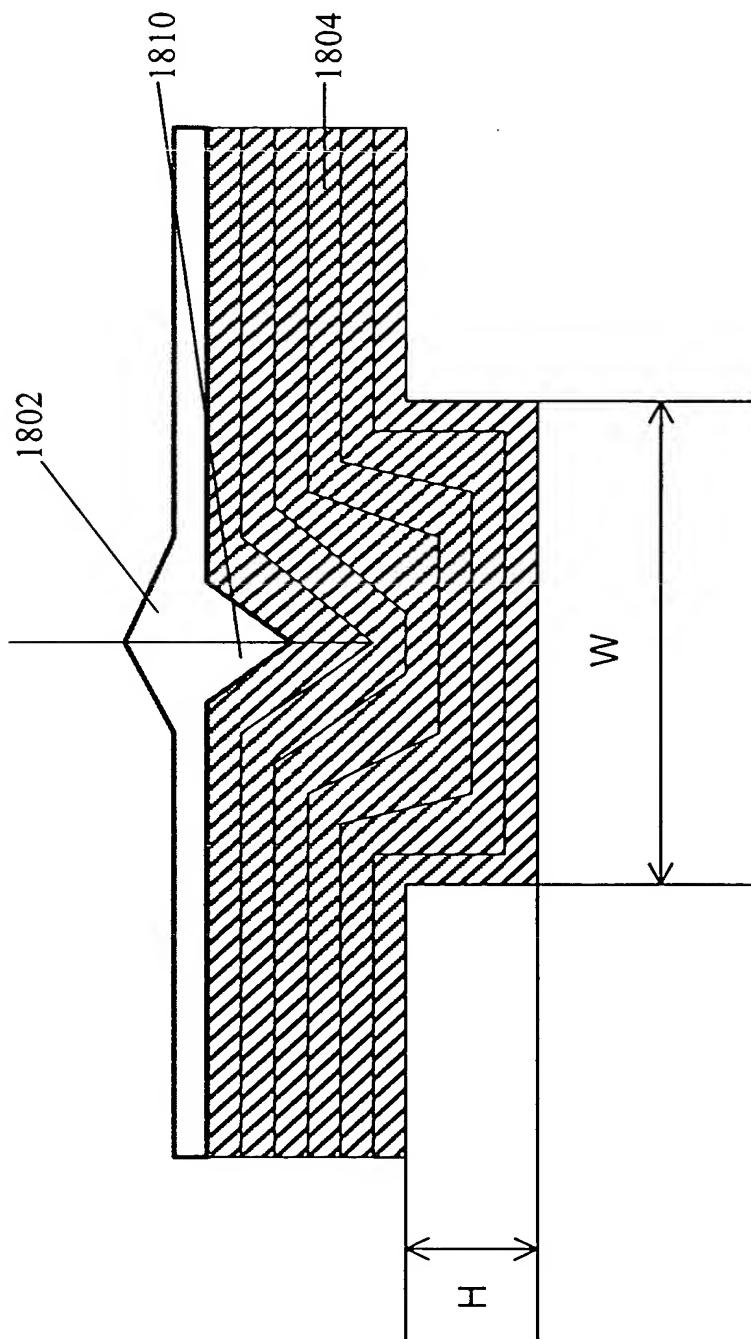


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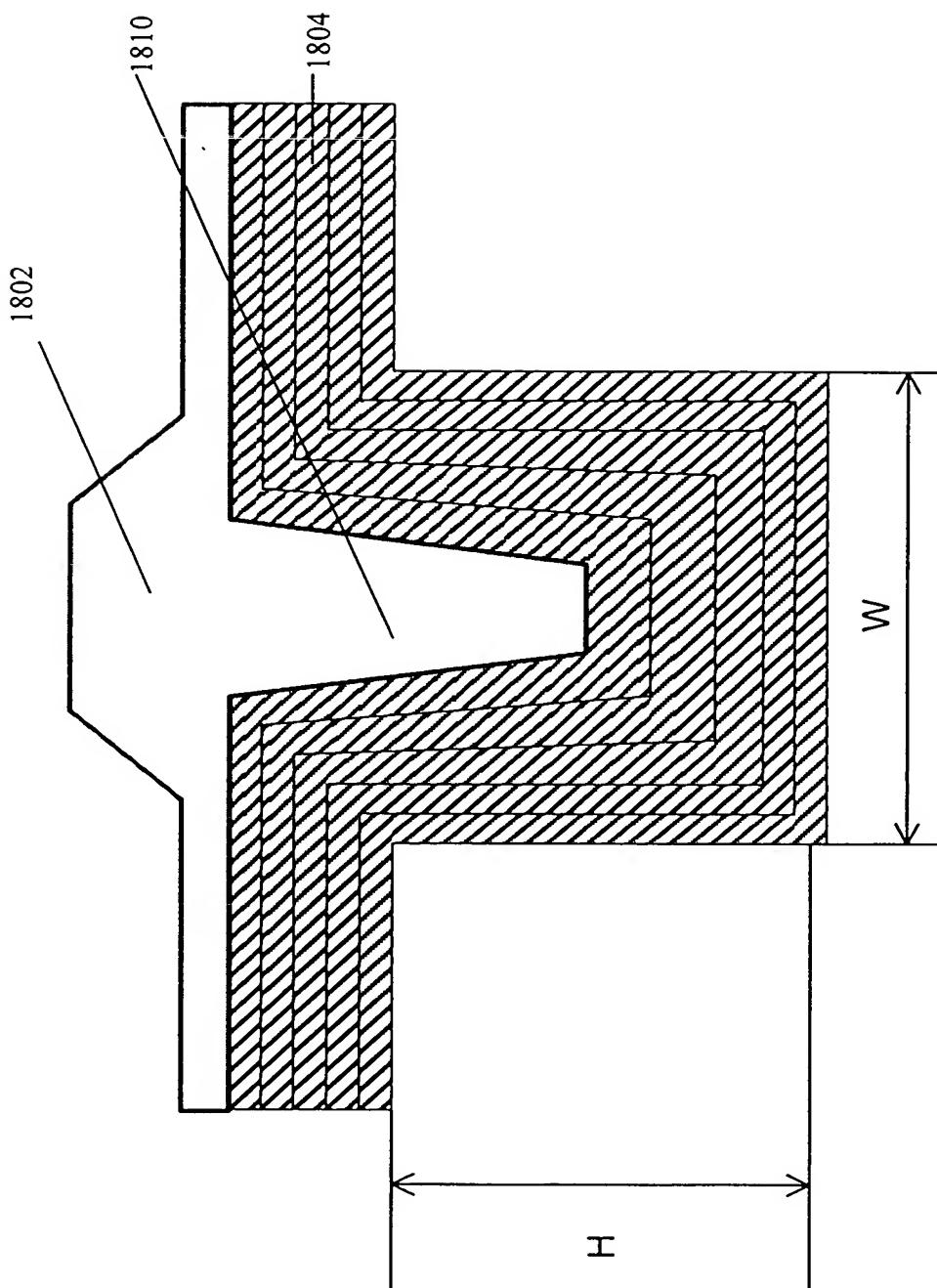


Fig. 18B

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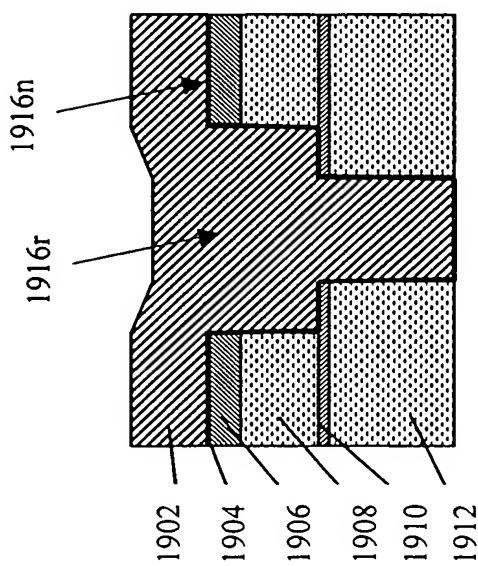


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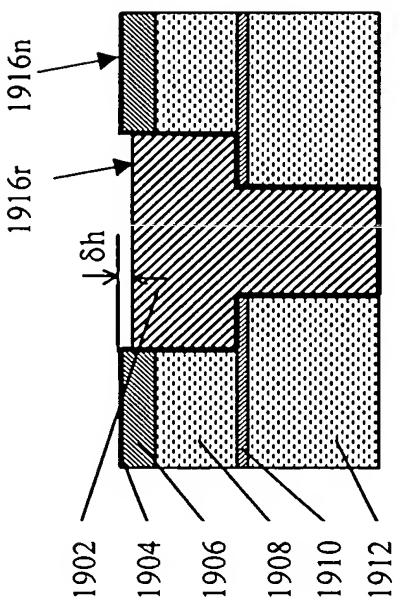


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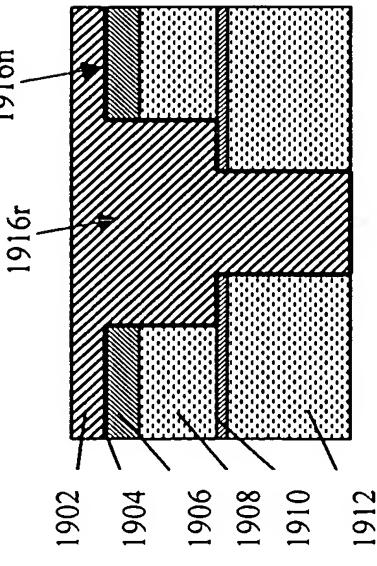


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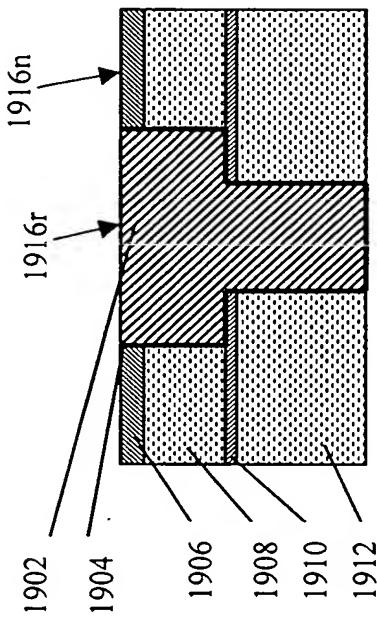
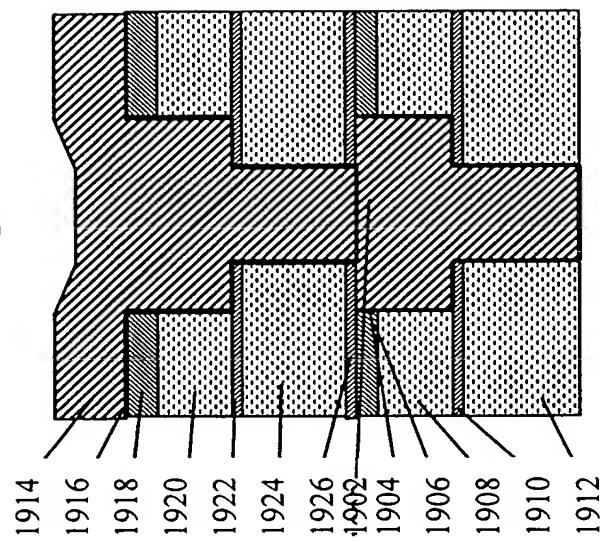
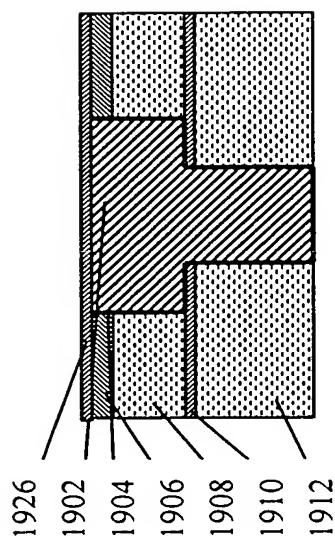


Fig. 19D

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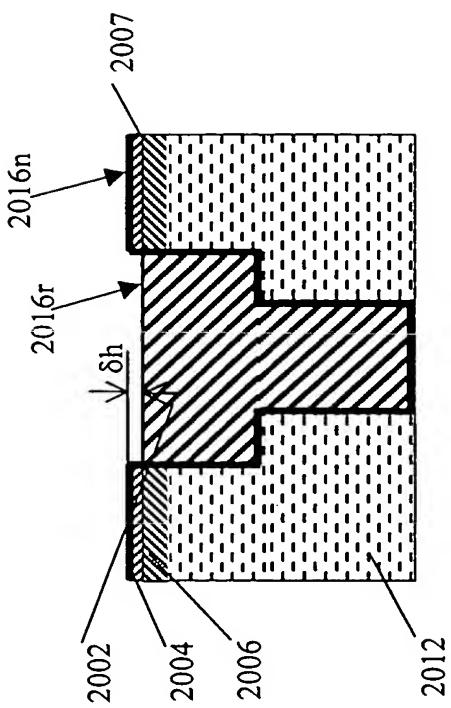


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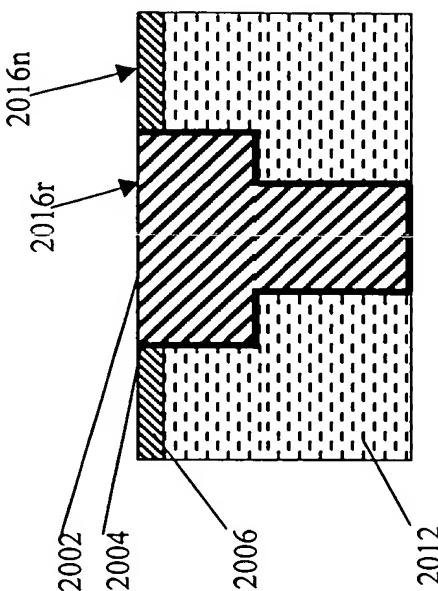


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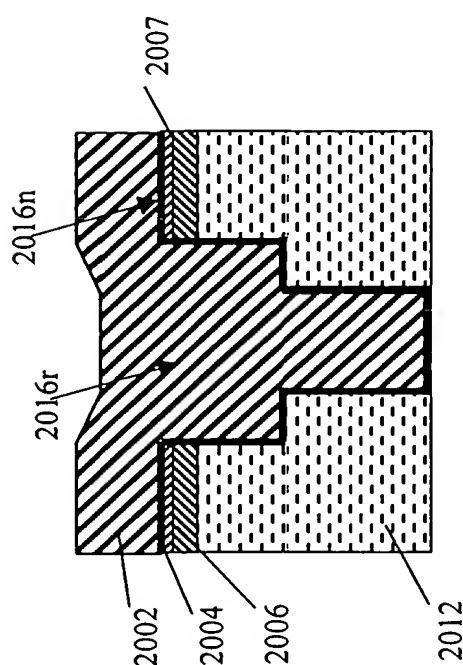


Fig. 20A

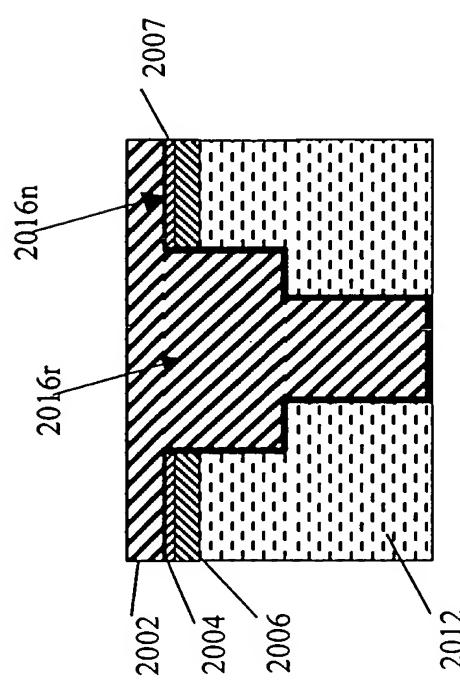
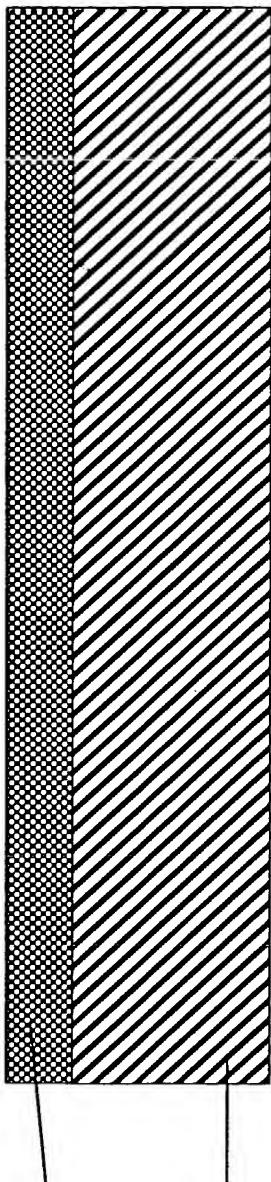


Fig. 20B

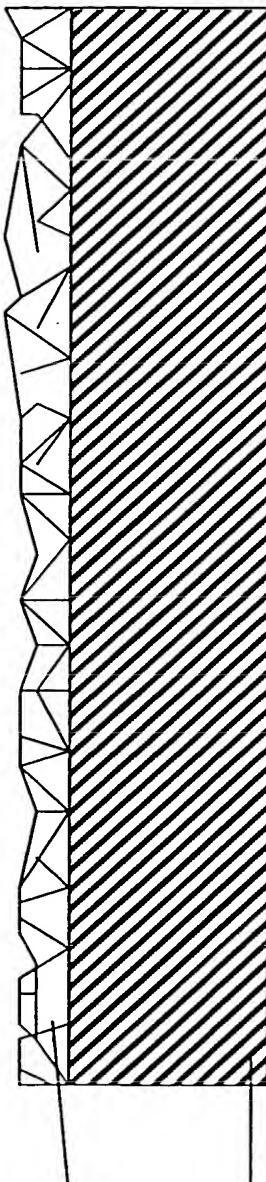
Fig. 21A



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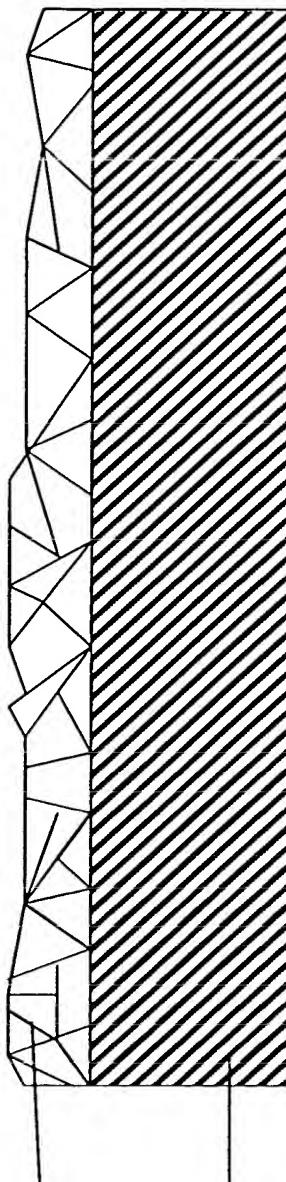
Fig. 21B



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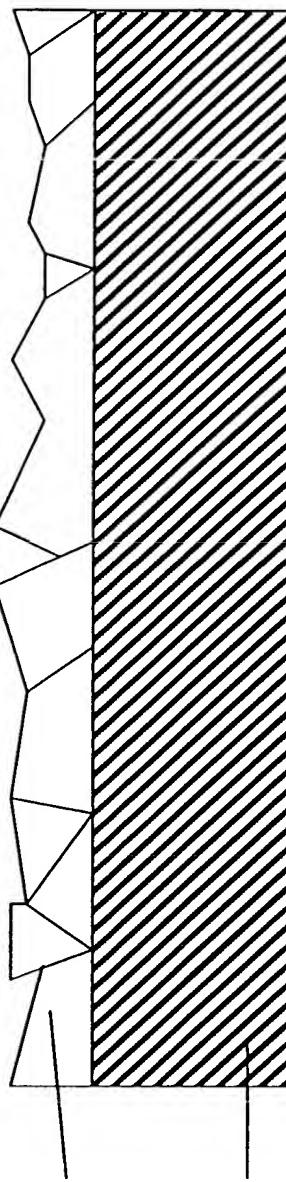
Fig. 21C



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2106

Fig. 21D



2100

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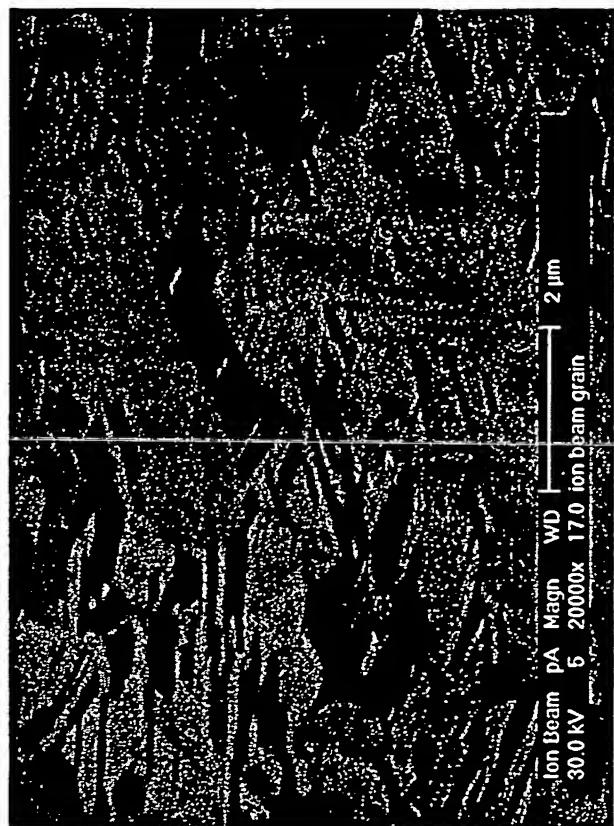


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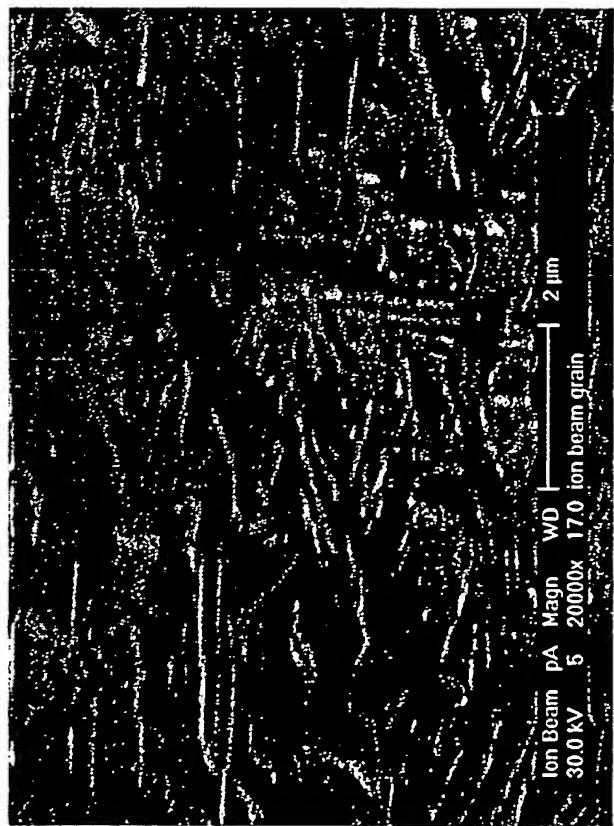


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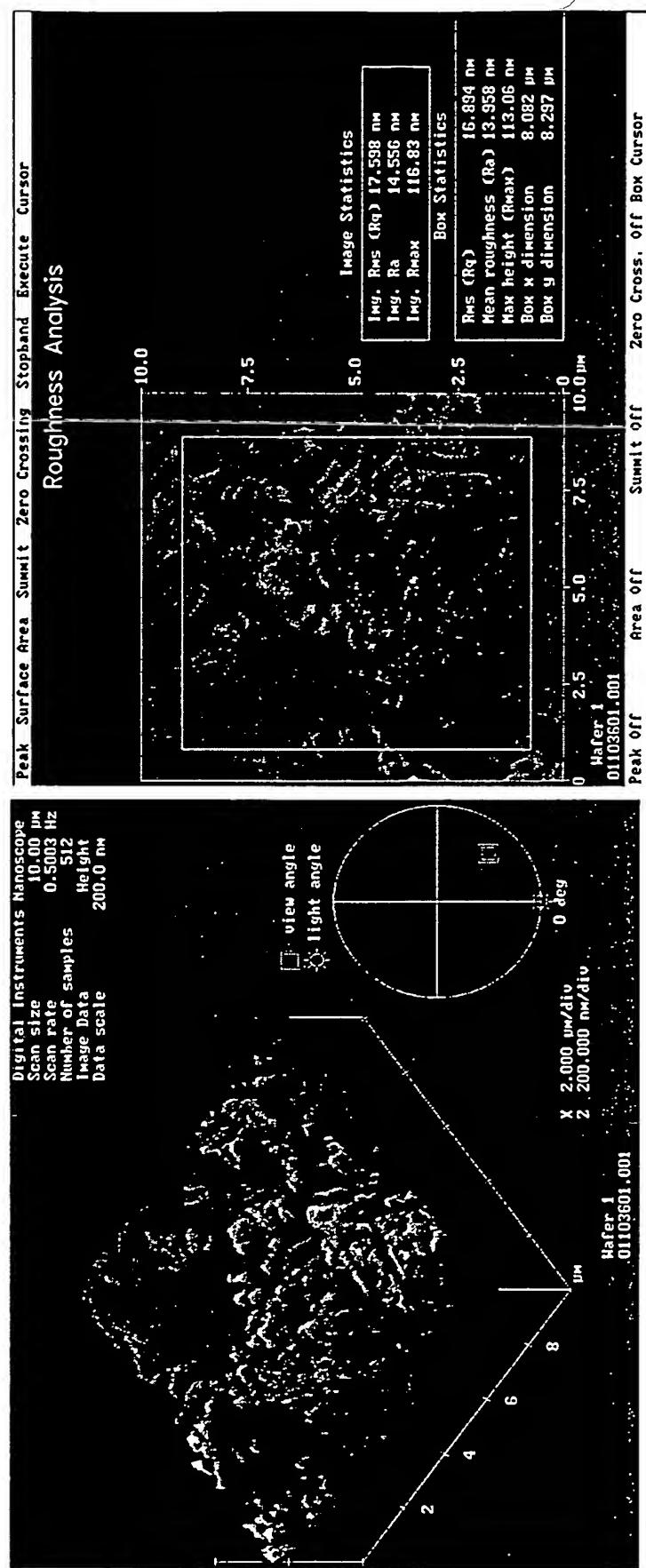


Fig. 22C

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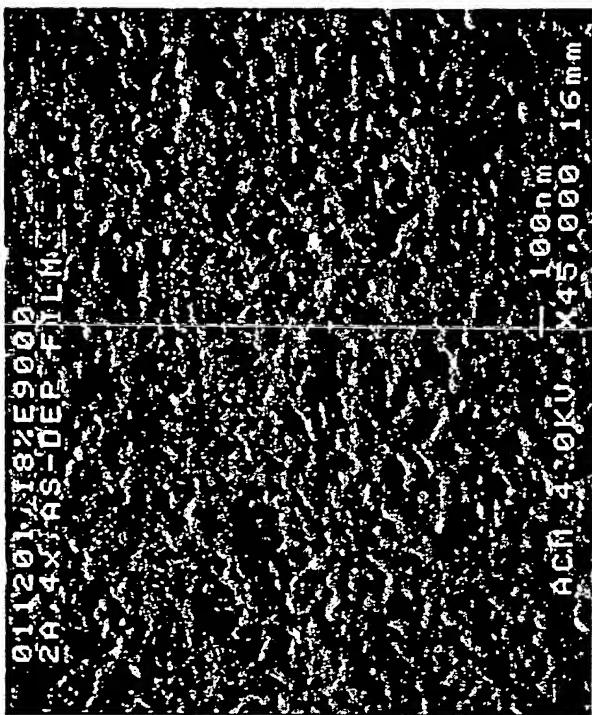


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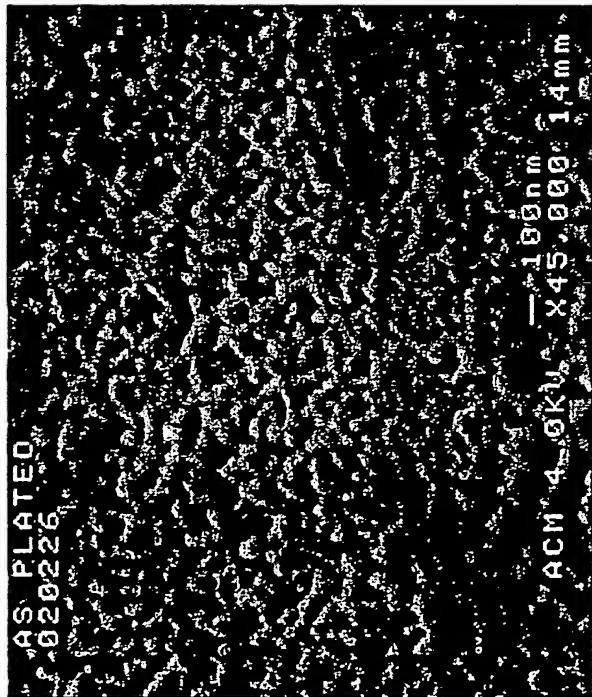


Fig. 23A

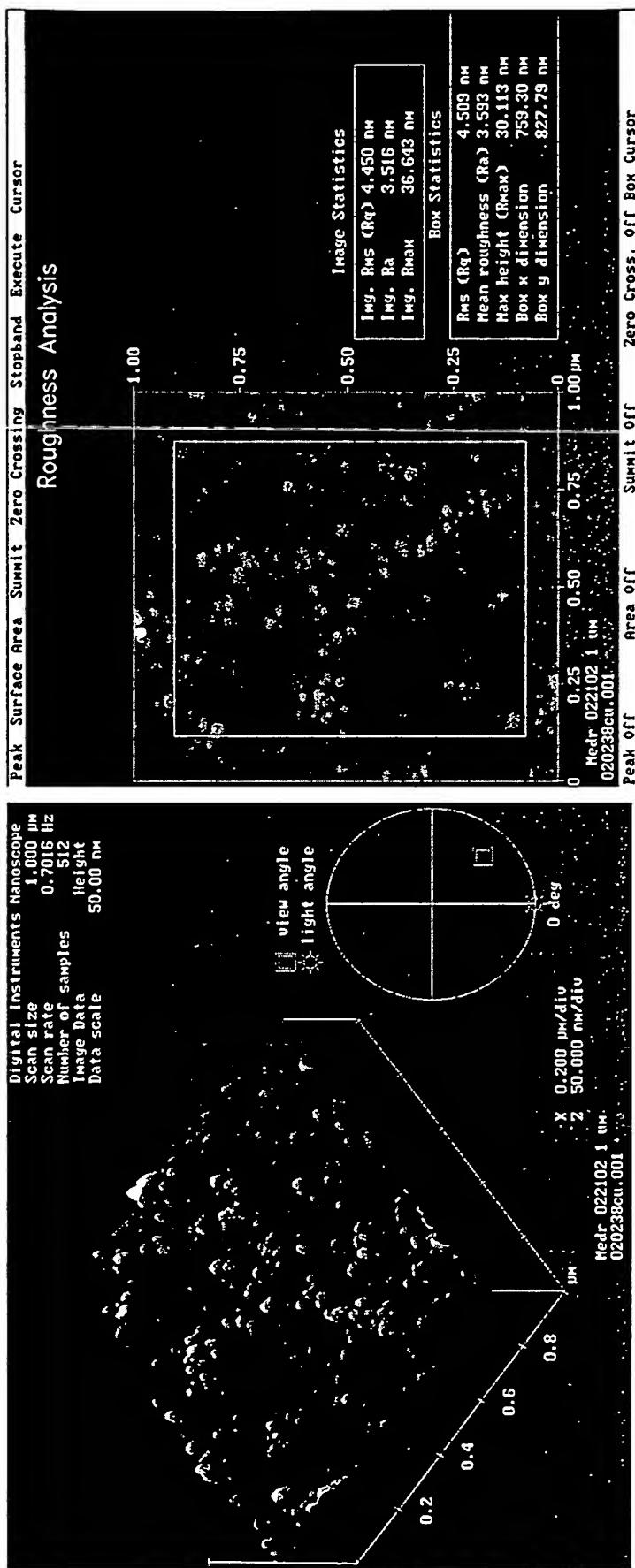


Fig. 23C

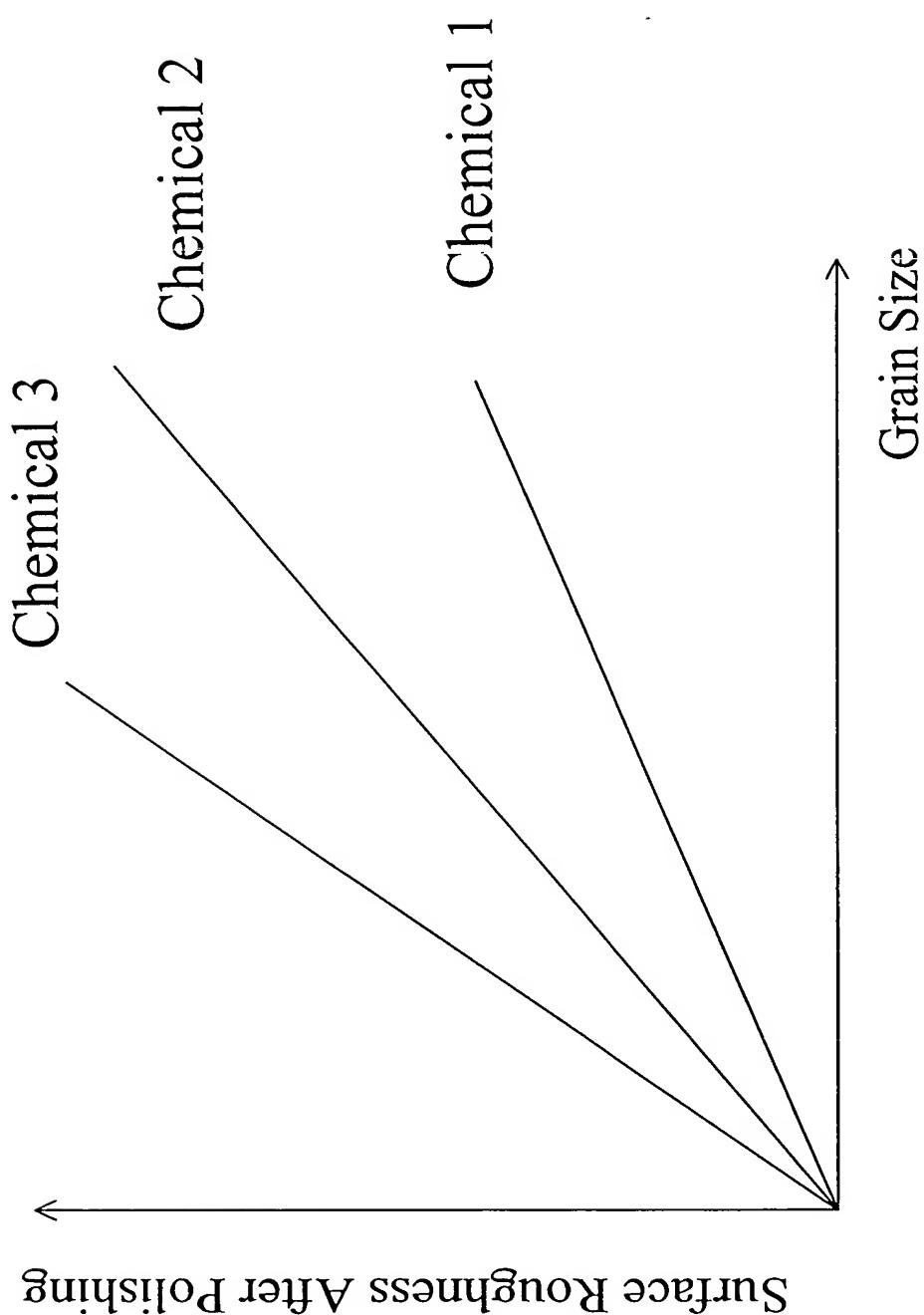
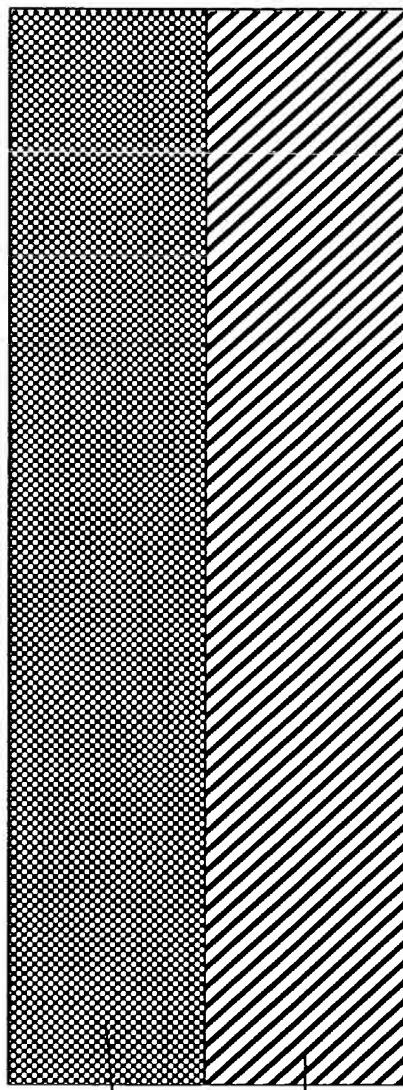


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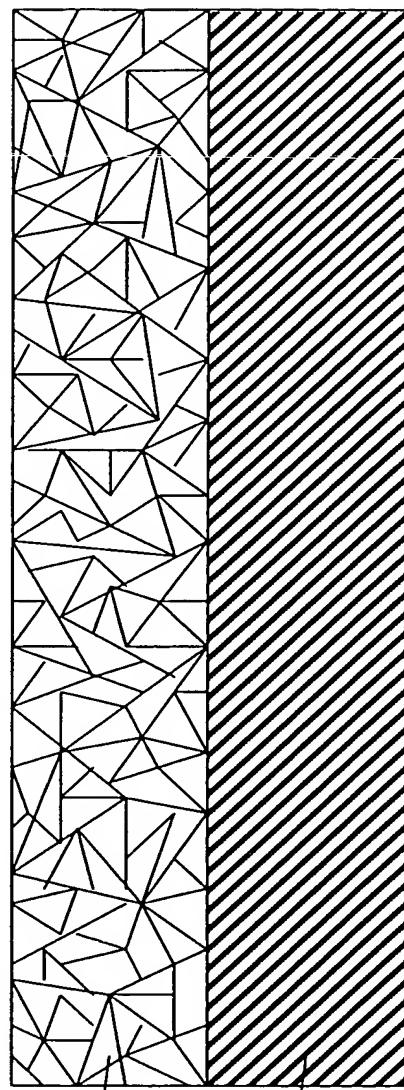
Fig. 25A



2502

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Fig. 25B



2504

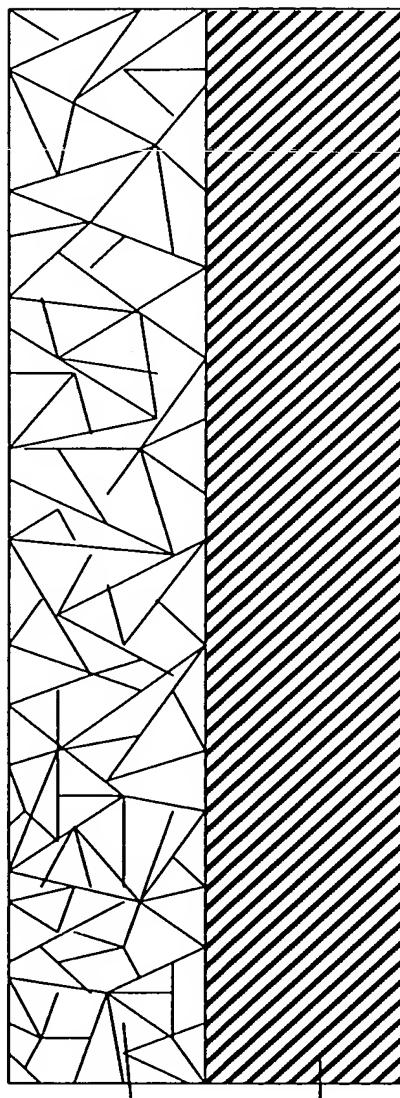
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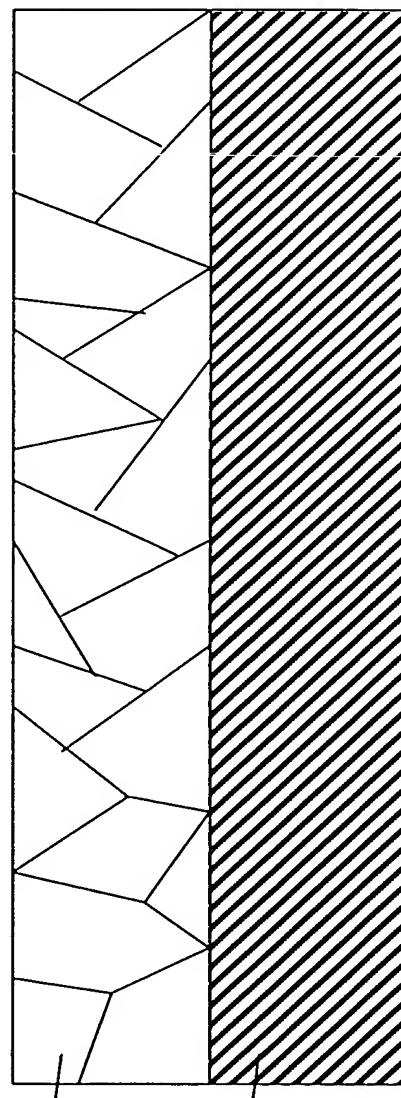
Fig. 25C



2506

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Fig. 25D



2508

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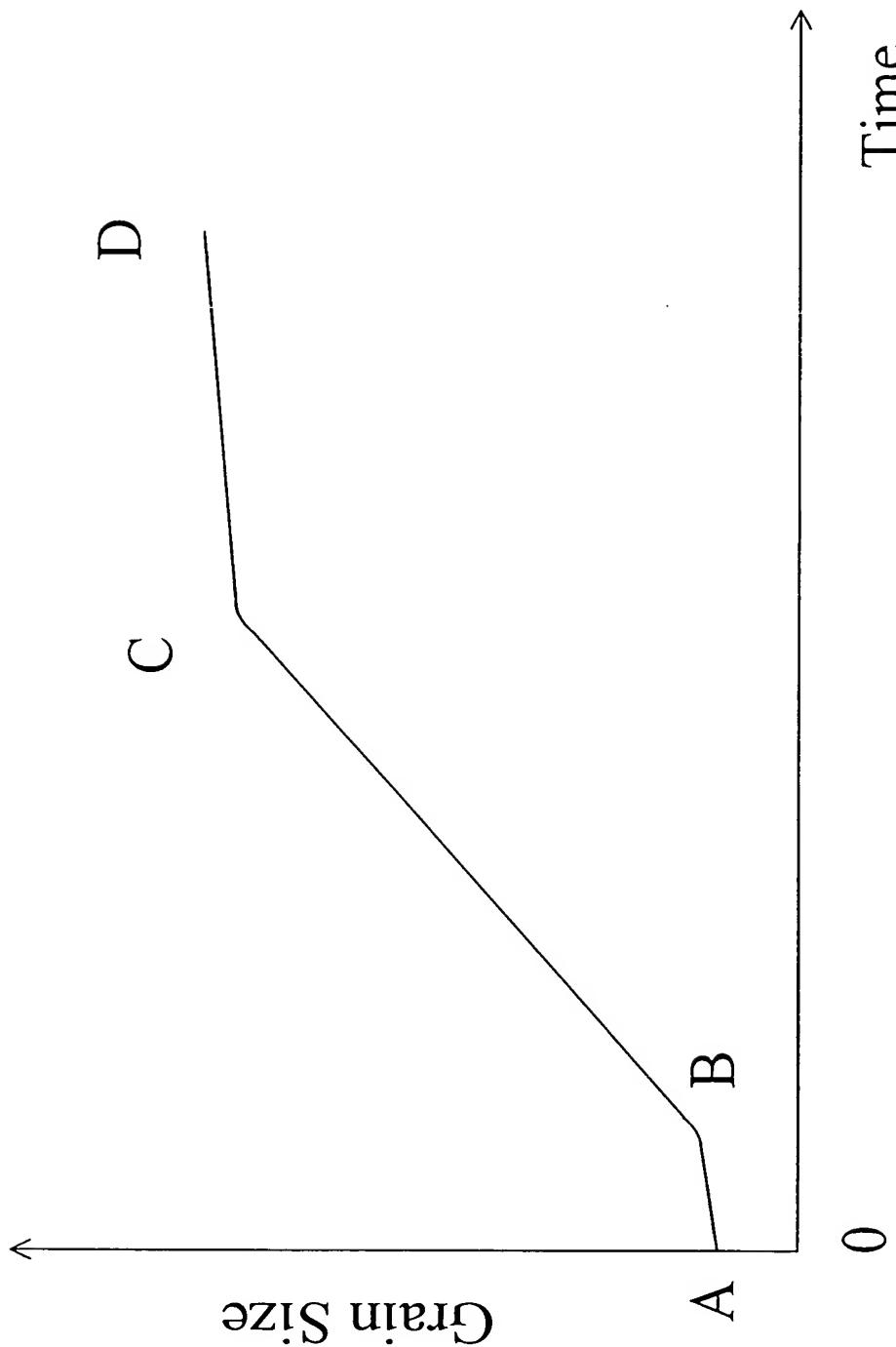


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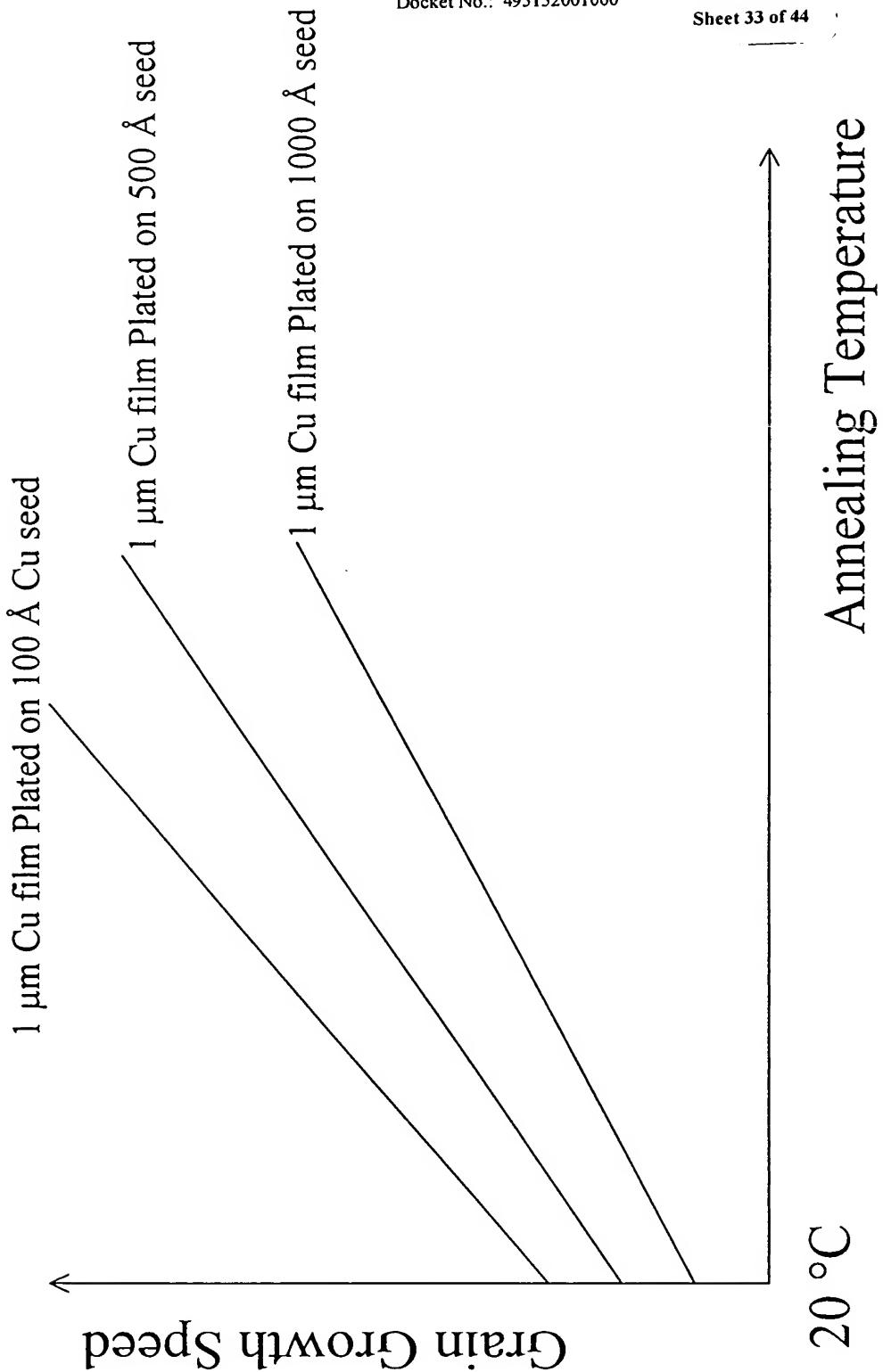


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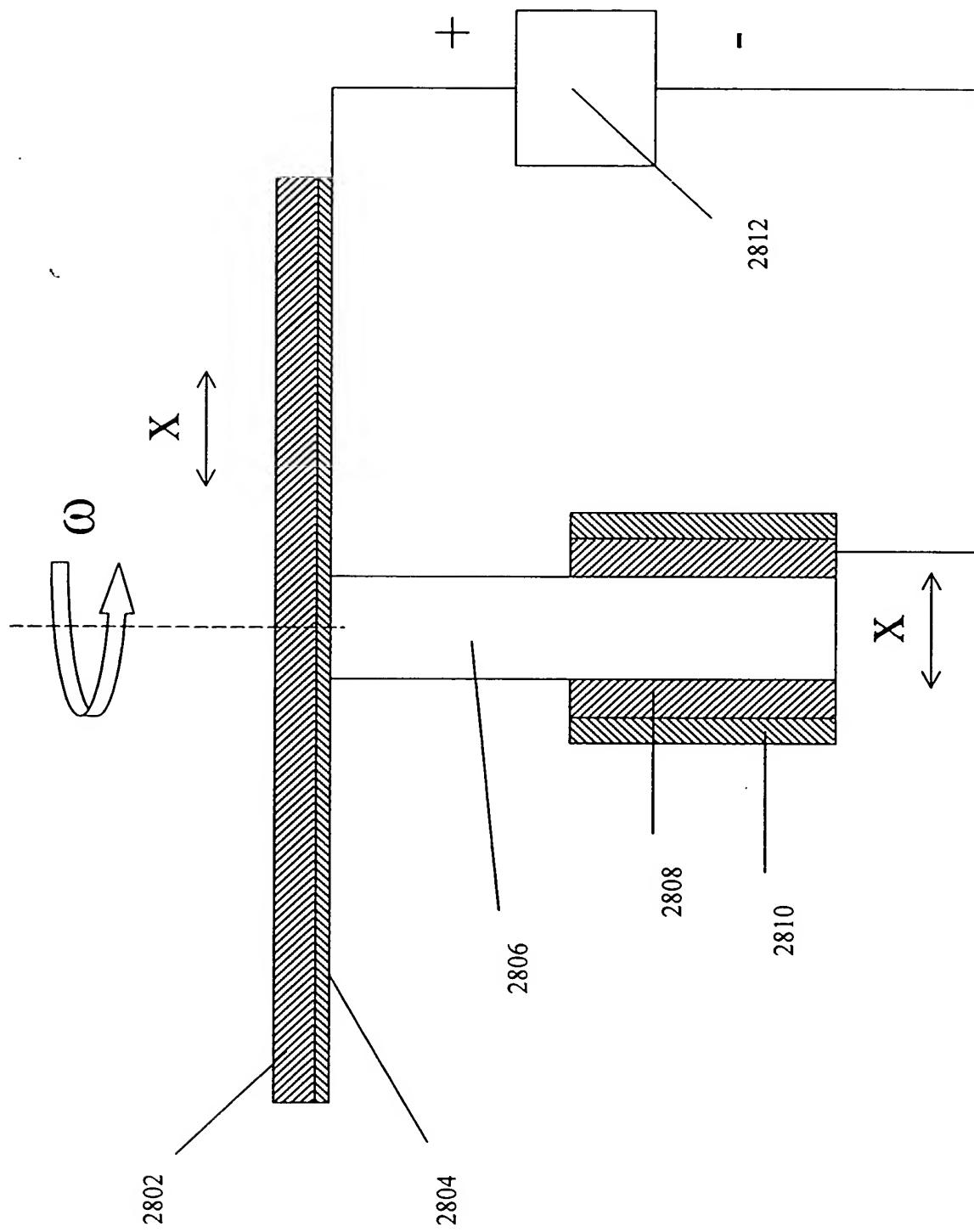


Fig. 28A

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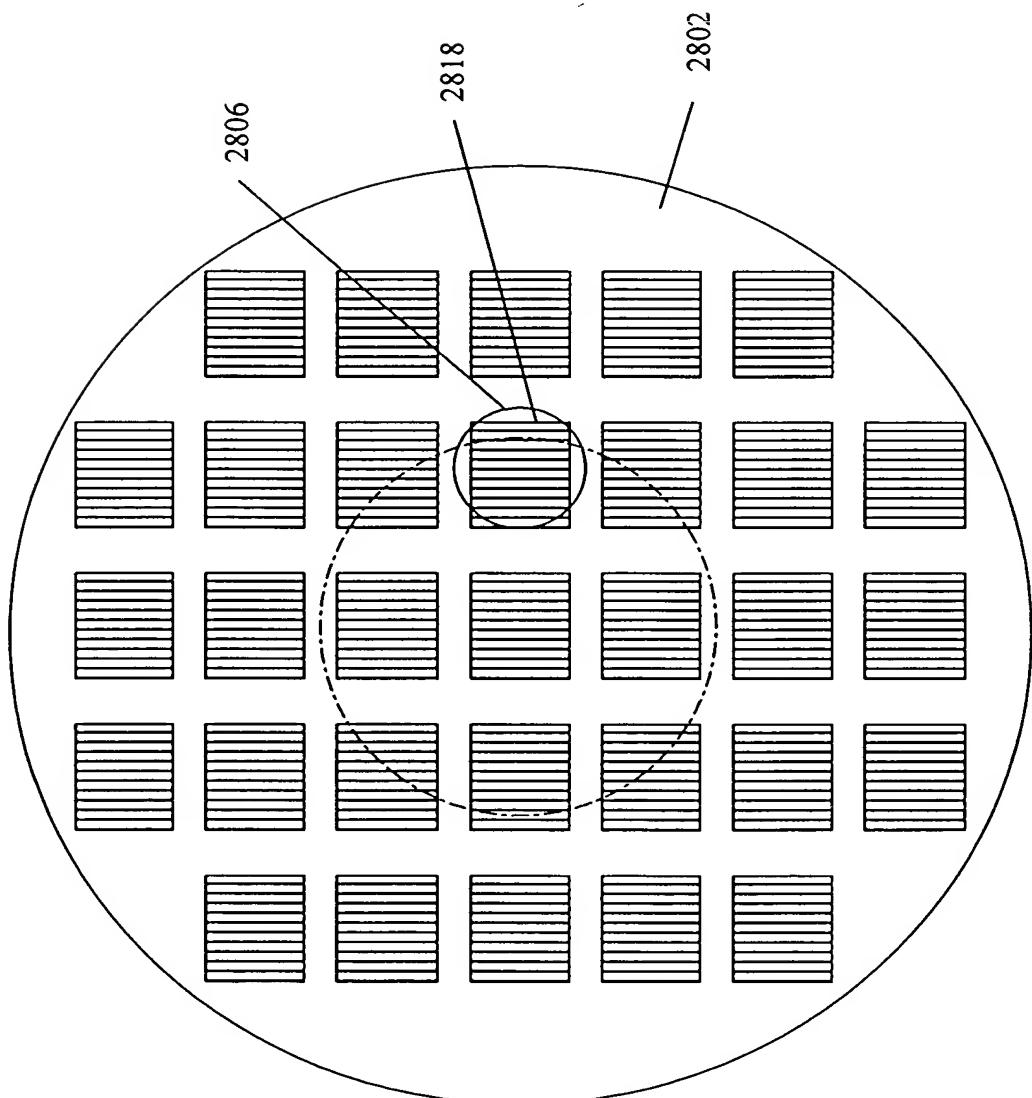


Fig. 28B

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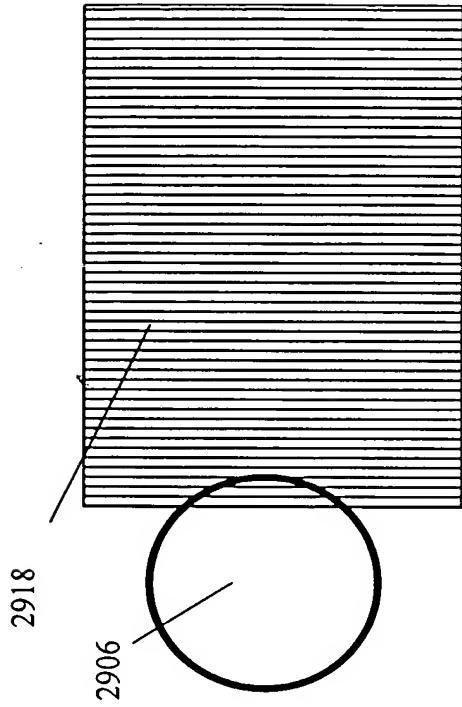


Fig. 29B

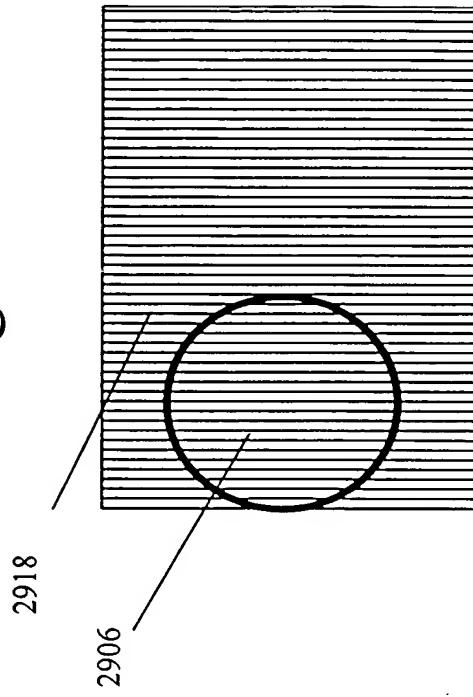


Fig. 29D

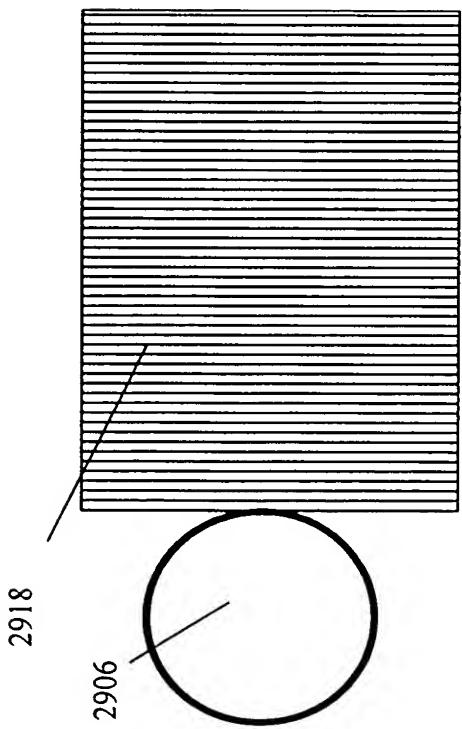


Fig. 29A

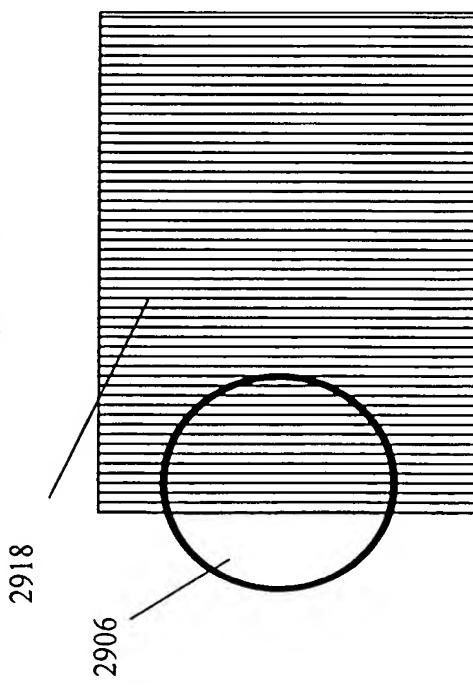
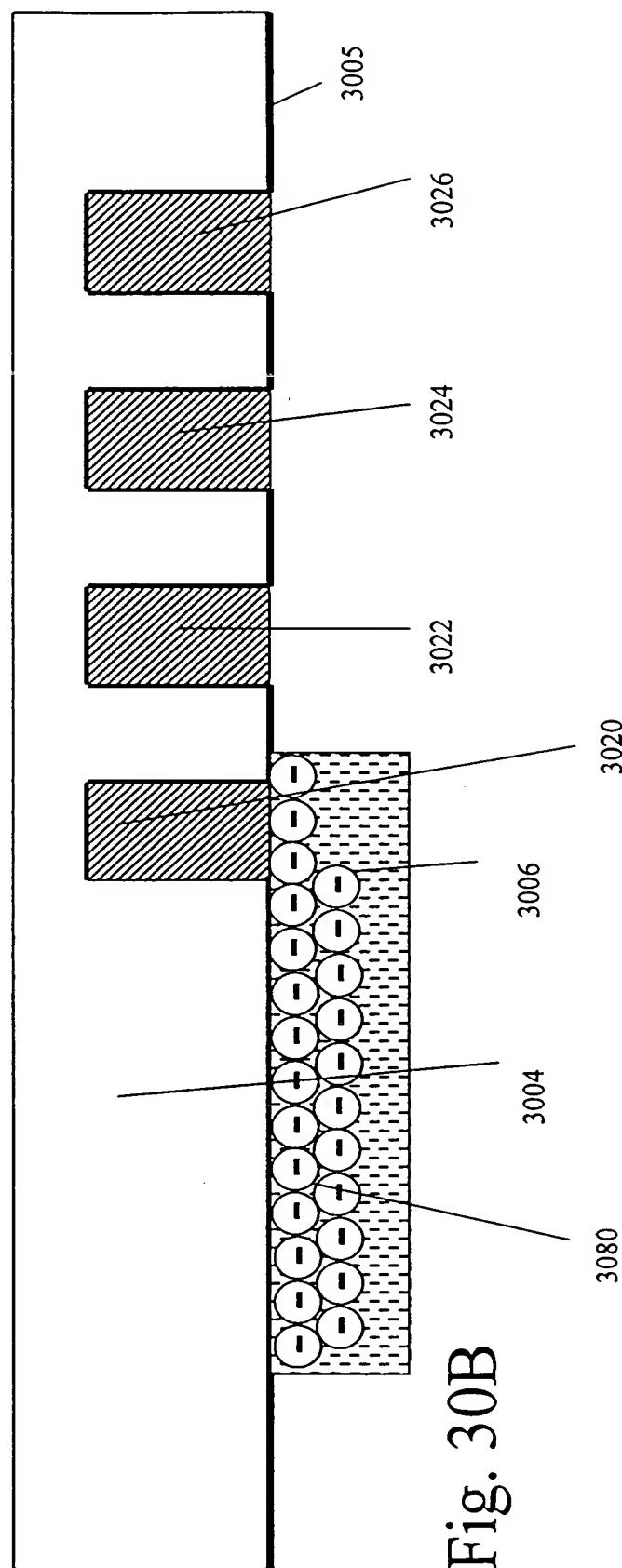
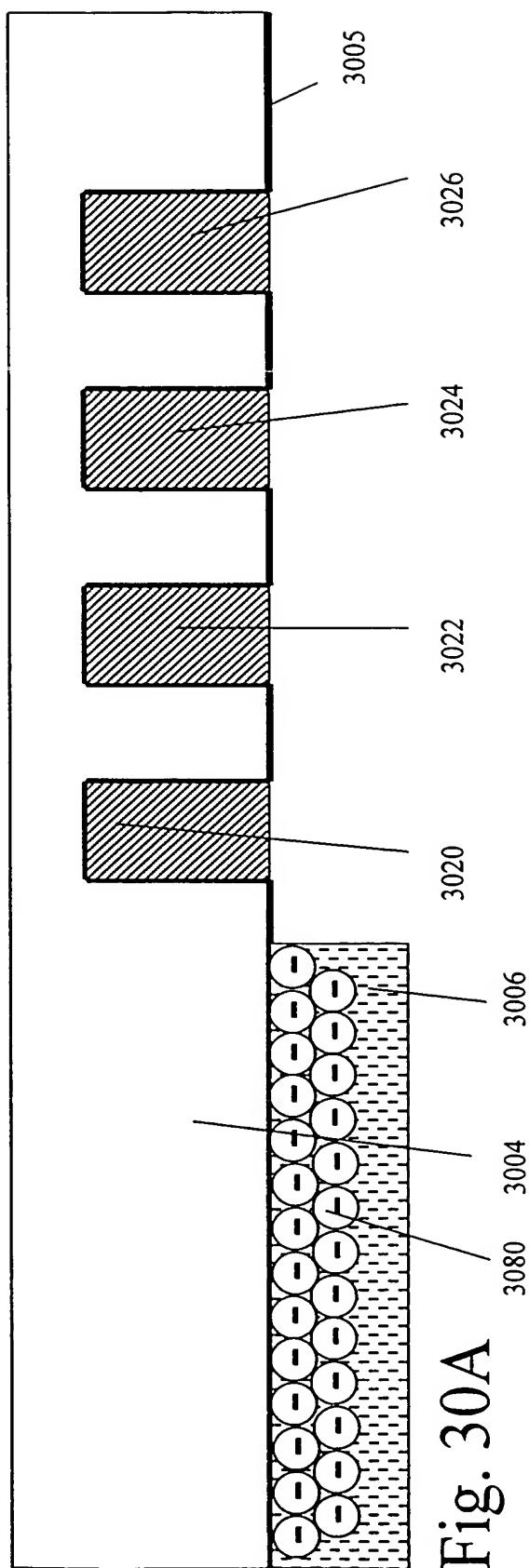
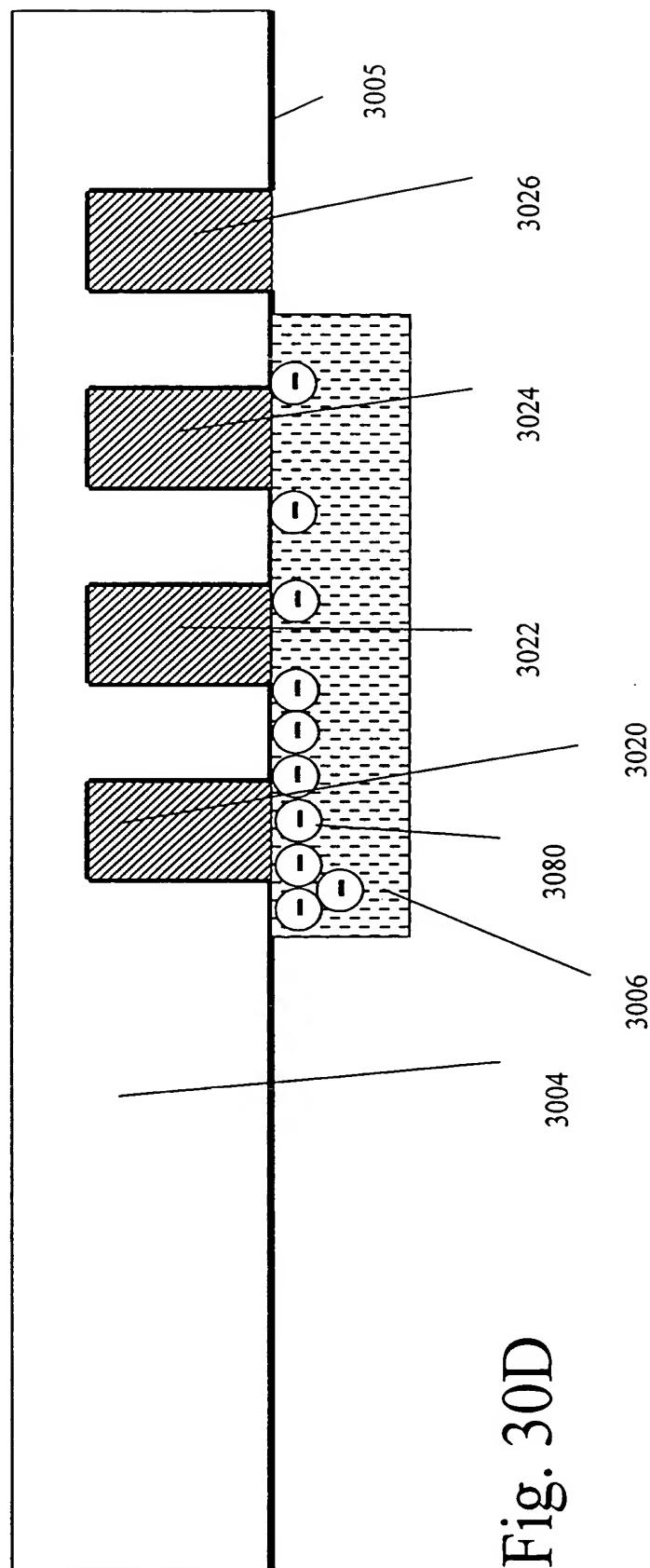
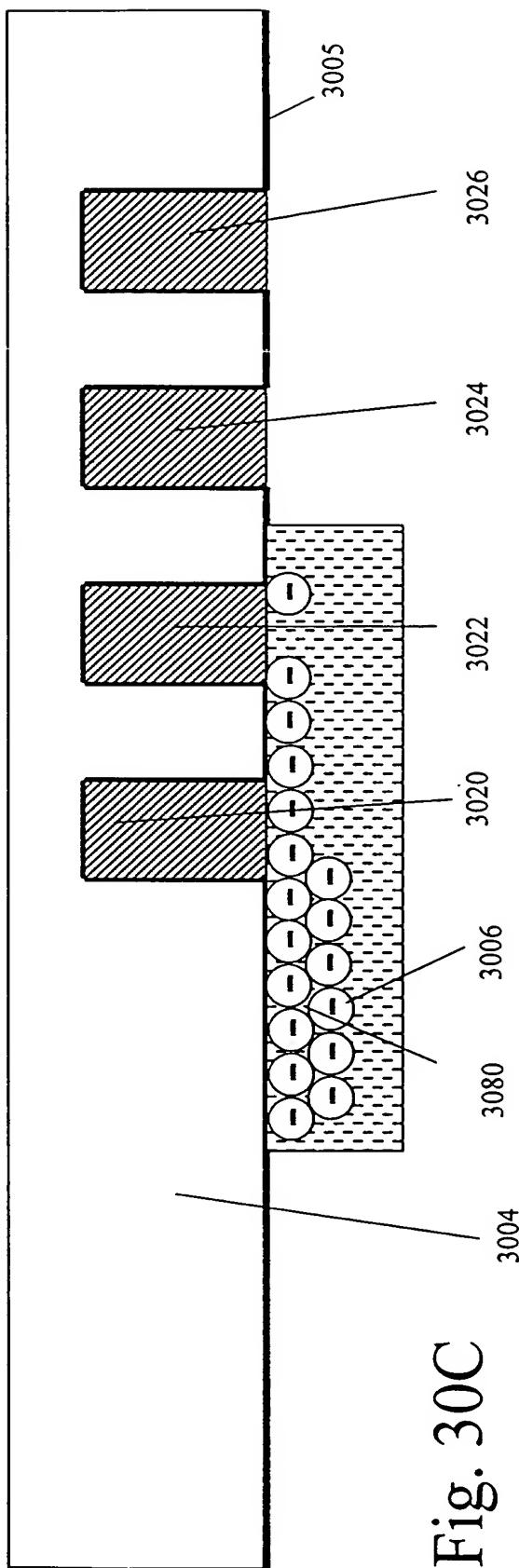


Fig. 29C





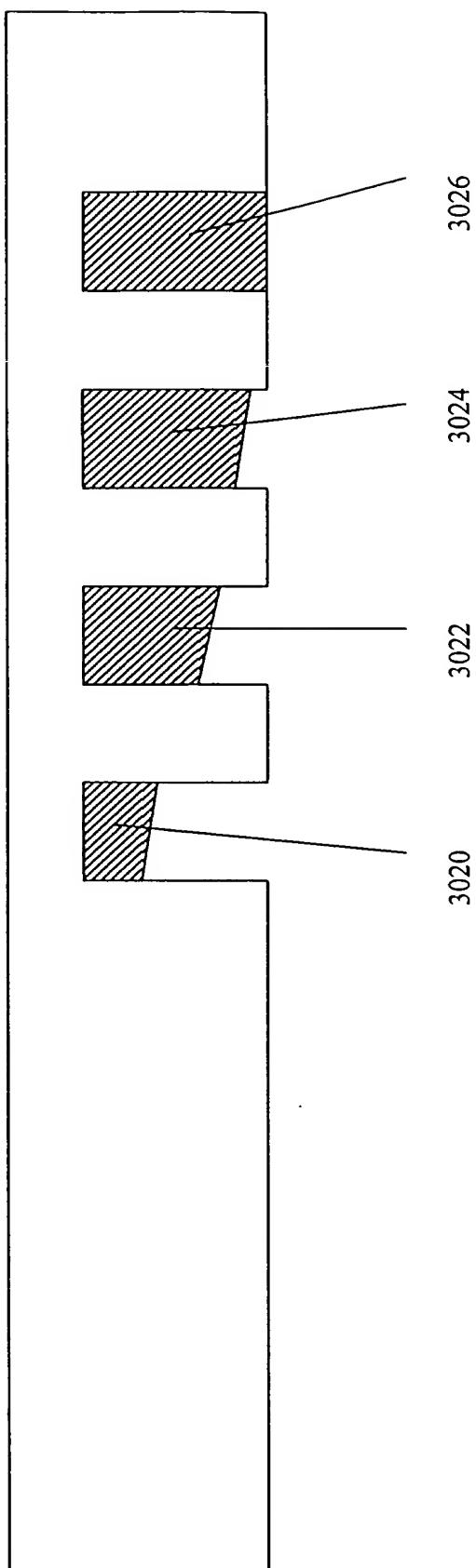


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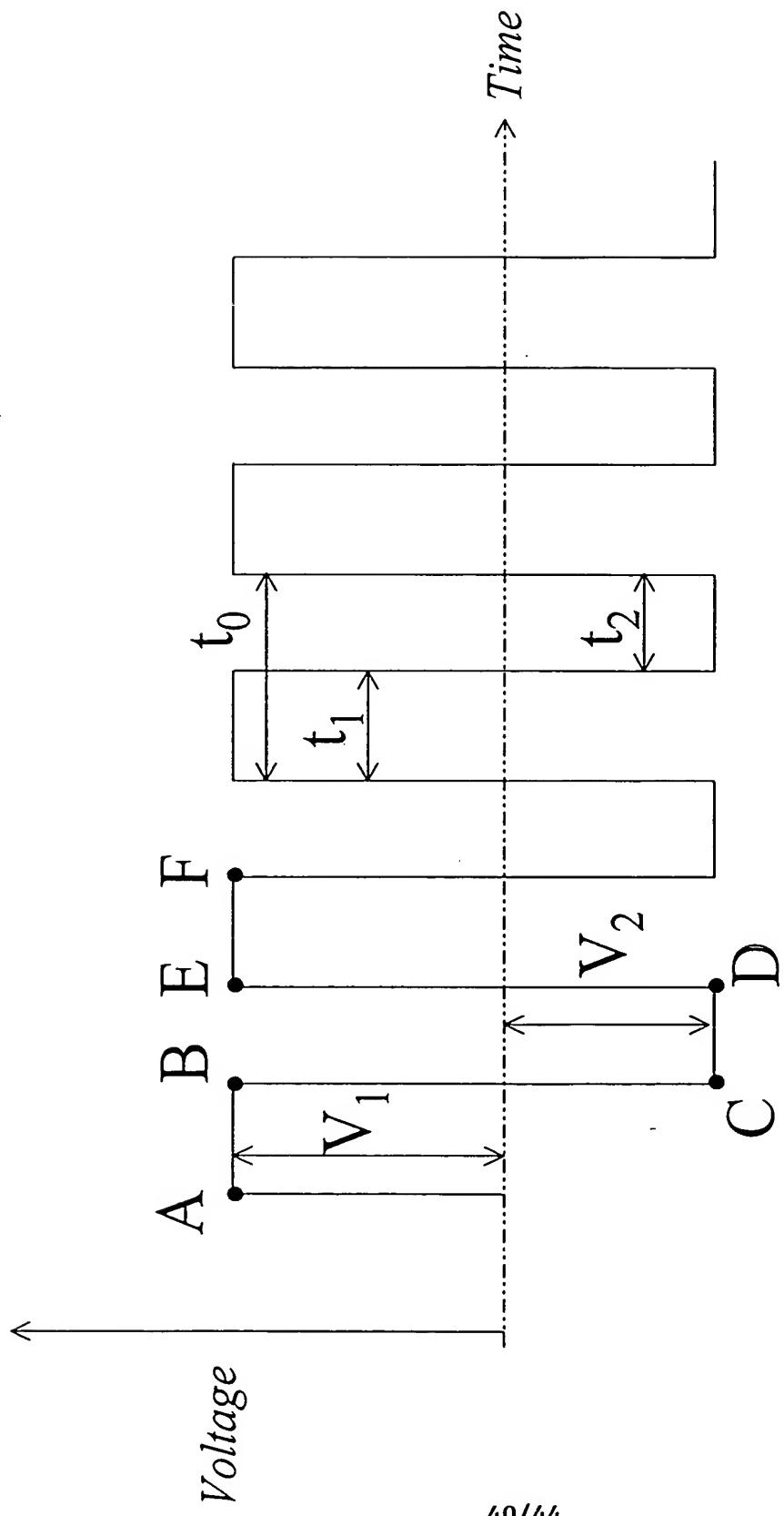


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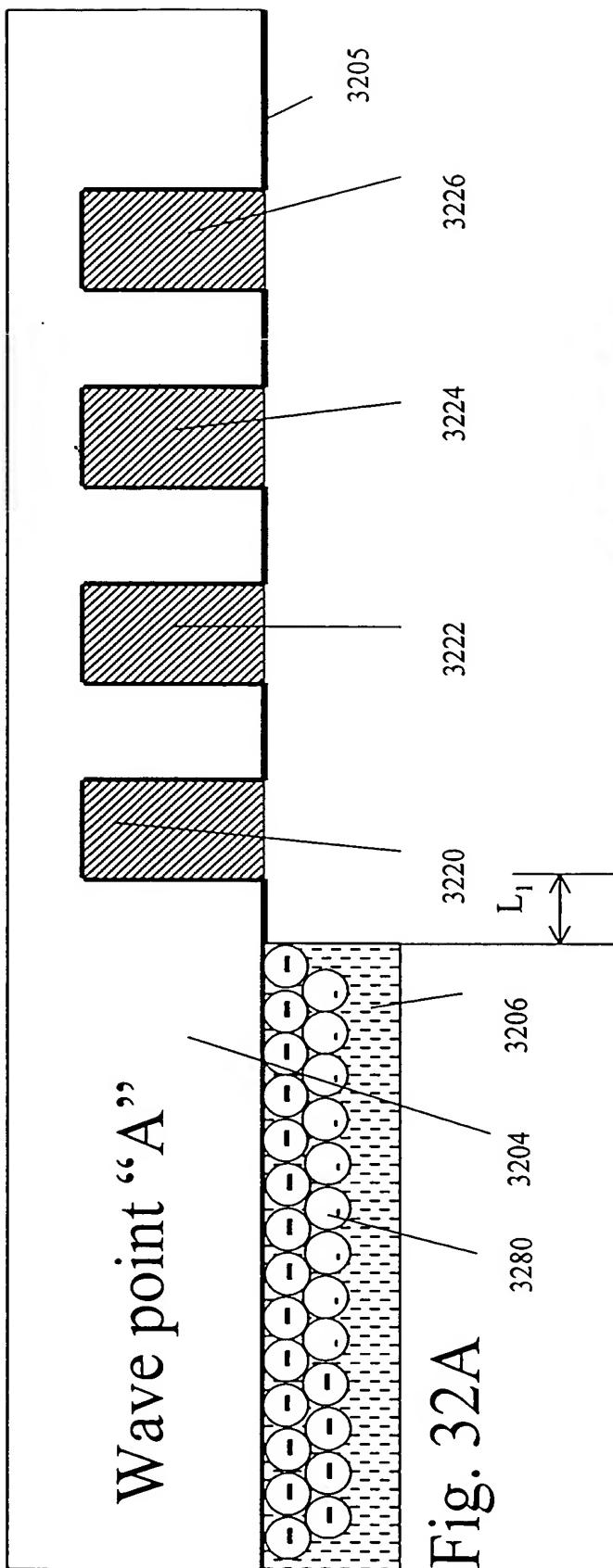


Fig. 32A

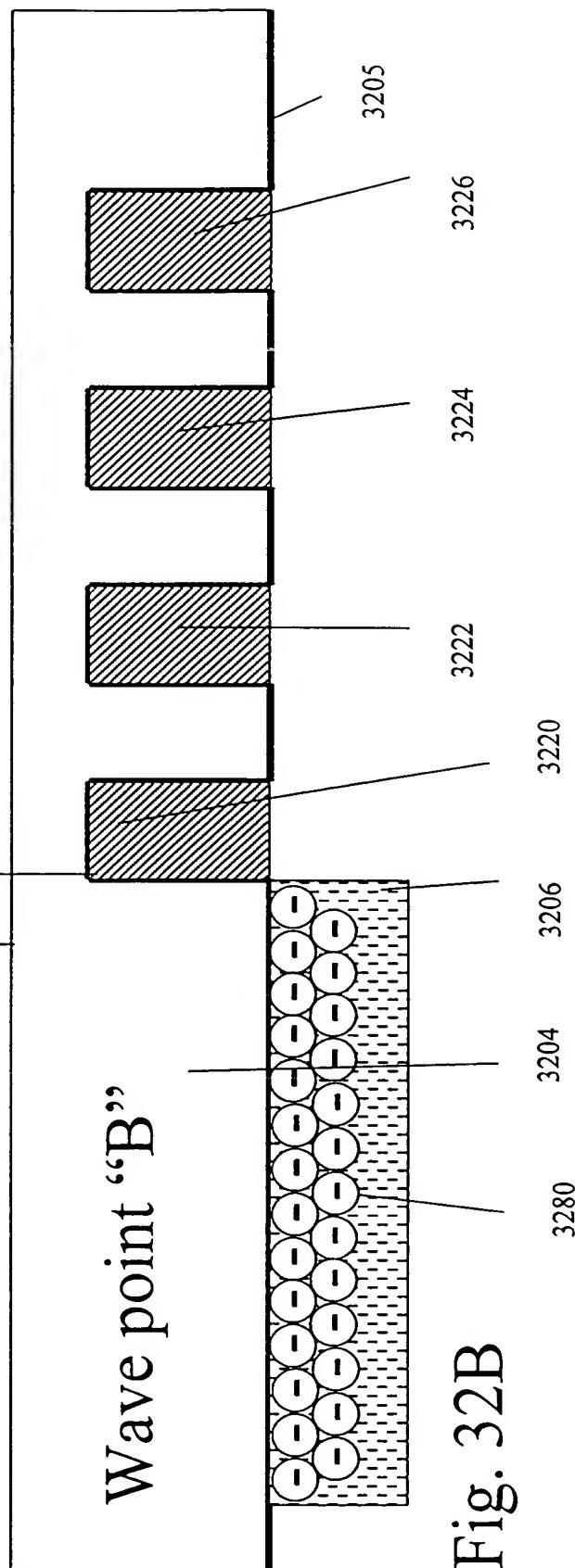
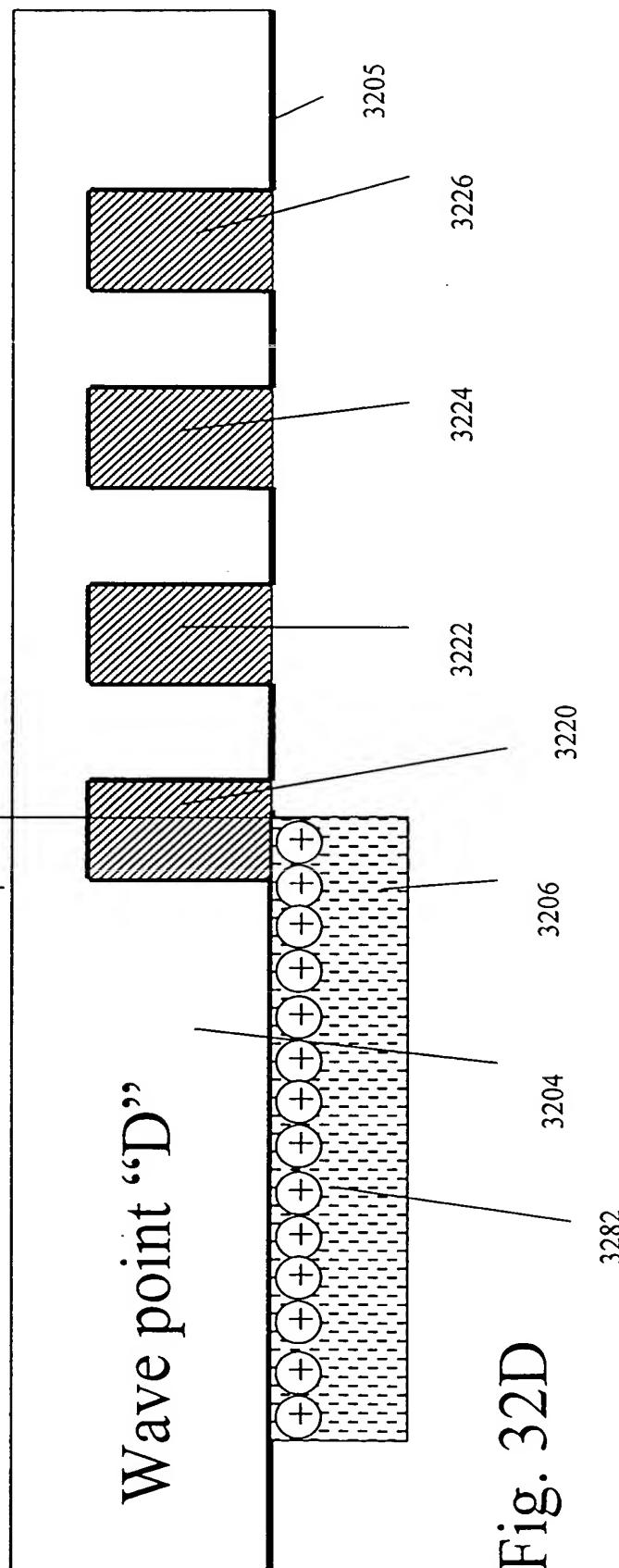
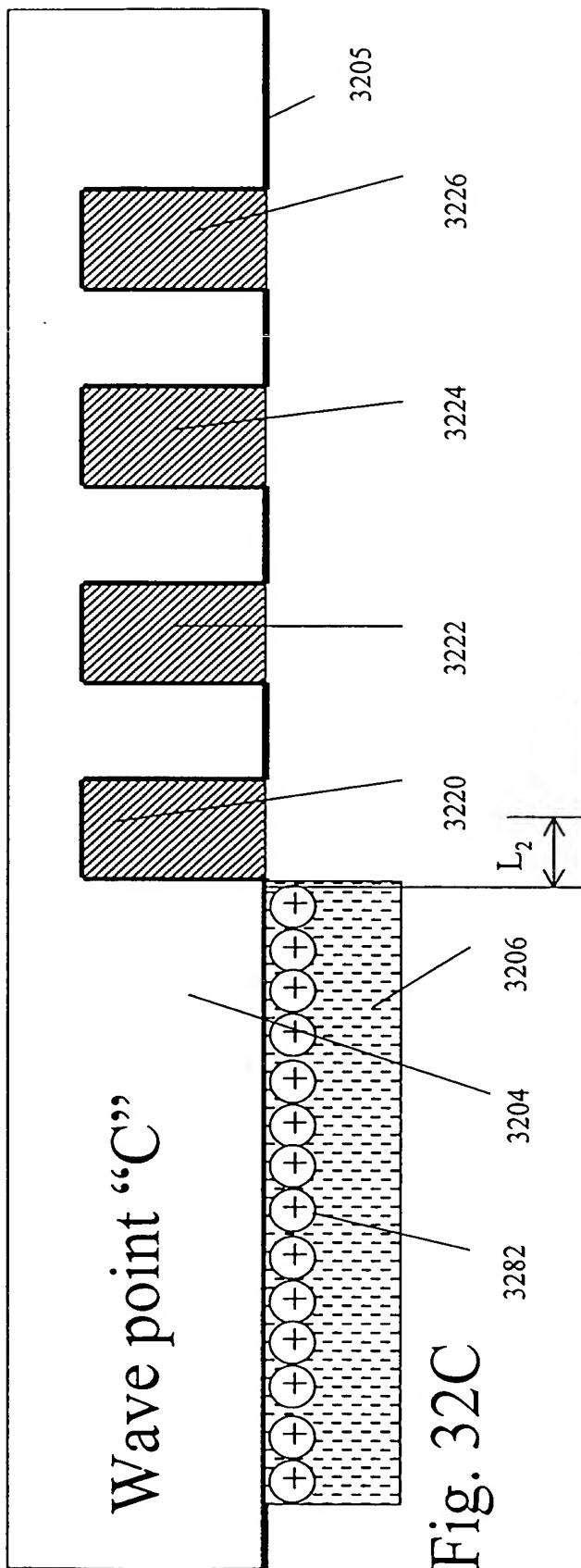
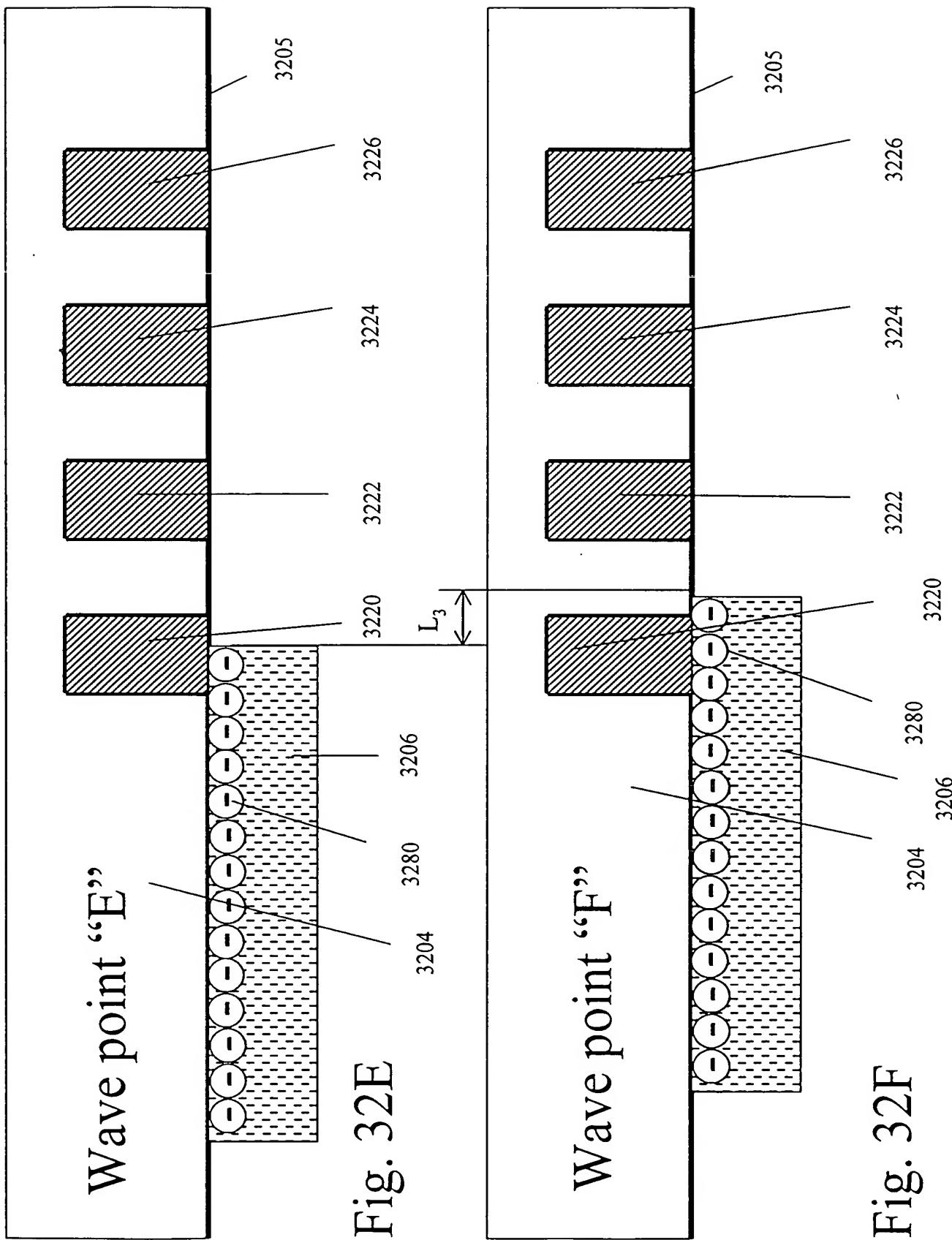


Fig. 32B





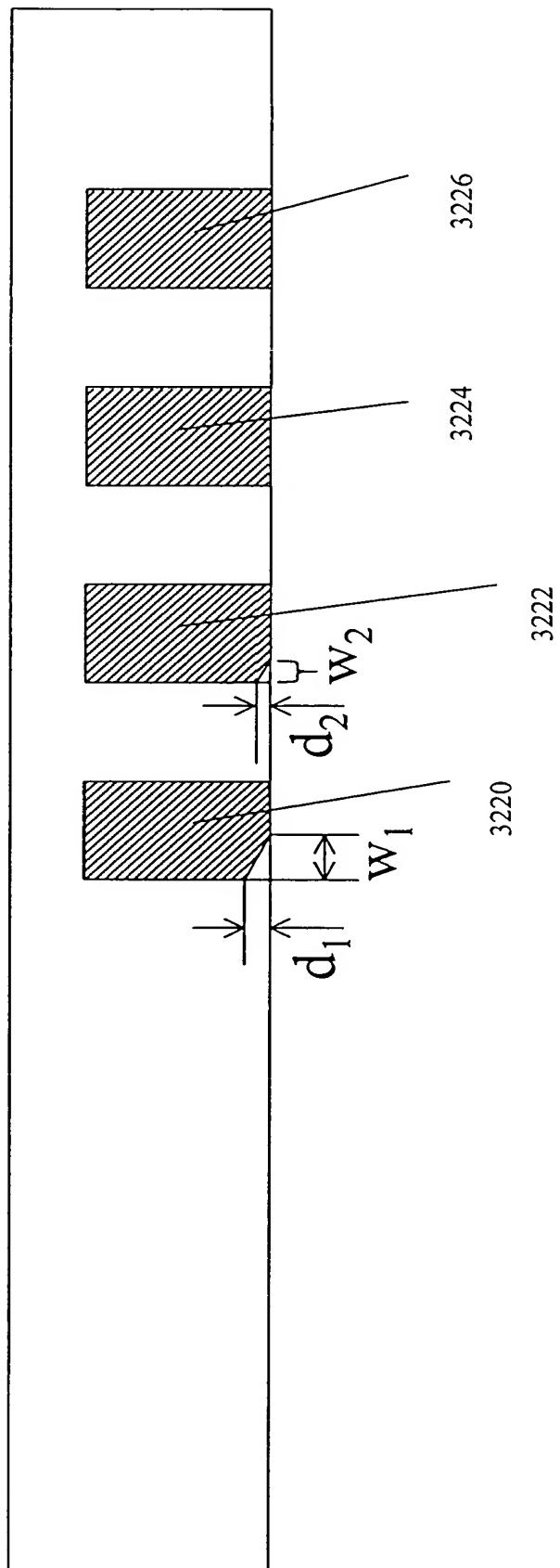


Fig. 32G